



## Quad/Octal, Simultaneous Sampling, 16-Bit Analog-to-Digital Converters

#### **FEATURES**

- Simultaneously Sample Four/Eight Channels
- Selectable Operating Modes:
   High-Speed: 52kSPS Data Rate, 31mW/ch
   Low-Power: 10kSPS Data Rate, 7mW/ch
- AC Performance:
   25kHz Bandwidth
   97dB SNR
   -105dB THD
- DC Performance: 2μV/°C Offset Drift 2ppm/°C Gain Drift
- Digital Filter:
   Linear Phase Response
   Passband Ripple: ±0.005dB
   Stop Band Attenuation: 100dB
- Selectable SPI™ or Frame Sync Serial Interface
- Simple Pin-Driven Control
- Low Sampling Aperture Error
- Specified from -40°C to +105°C
- Analog Supply: 5V
- I/O Supply: 1.8V to 3.3VDigital Core Supply: 1.8V

#### **APPLICATIONS**

- 3-Phase Power Monitors
- Defibrillators and ECG Monitors
- Coriolis Flow Meters
- Vibration/Modal Analysis

#### **DESCRIPTION**

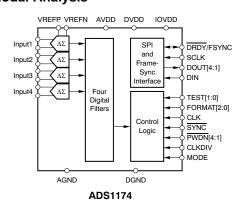
The ADS1174 (quad) and ADS1178 (octal) are multiple delta-sigma ( $\Delta\Sigma$ ) analog-to-digital converters (ADCs) with data rates up to 52k samples-per-second (SPS), which allow synchronous sampling of four and eight channels. These devices use identical packages, and are also compatible with the high-performance 24-bit ADS1274 and ADS1278, permitting drop-in upgrades.

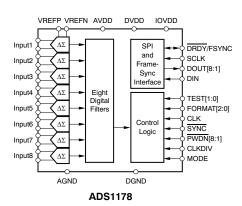
The delta-sigma architecture offers near ideal 16-bit ac performance (97dB SNR, -105dB THD, 1LSB linearity) combined with 0.005dB passband ripple and linear phase response.

The high-order, chopper-stabilized modulator achieves very low drift ( $2\mu V/^{\circ}C$  offset,  $2ppm/^{\circ}C$  gain) and low noise ( $1LSB_{PP}$ ). The on-chip finite impulse response (FIR) filter provides a usable signal bandwidth up to 90% of the Nyquist rate with 100dB of stop band attenuation while suppressing modulator and signal out-of-band noise.

Two operating modes allow for optimization of speed and power: High-speed mode (31mW/Ch at 52kSPS), and Low-power mode (7mW/Ch at 10kSPS).

A SYNC input control pin allows the device conversions to be started and synchronized to an external event. SPI and Frame-Sync serial interfaces are supported. The device is fully specified over the extended industrial range (−40°C to +105°C) and is available in an HTQFP-64 PowerPAD™ package.





A

Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

PowerPAD is a trademark of Texas Instruments.

SPI is a trademark of Motorola, Inc.

All other trademarks are the property of their respective owners.





This integrated circuit can be damaged by ESD. Texas Instruments recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage.

ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

#### **ORDERING INFORMATION**

For the most current package and ordering information see the Package Option Addendum at the end of this document, or see the TI web site at www.ti.com.

#### **ABSOLUTE MAXIMUM RATINGS**

over operating free-air temperature range unless otherwise noted (1)

PARAMETER	ADS1174, ADS1178	UNIT
AVDD to AGND	-0.3 to +6.0	V
DVDD, IOVDD to DGND	-0.3 to +3.6	V
AGND to DGND	-0.3 to +0.3	V
land Comment	100, Momentary	mA
Input Current	10, Continuous	mA
Analog Input to AGND	-0.3 to AVDD + 0.3	V
Digital Input or Output to DGND	-0.3 to IOVDD + 0.3	V
Maximum Junction Temperature	+150	°C
Operating Temperature Range	-40 to +125	°C
Storage Temperature Range	-60 to +150	°C

<sup>(1)</sup> Stresses above these ratings may cause permanent damage. Exposure to absolute maximum conditions for extended periods may degrade device reliability. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those specified is not implied.



#### **ELECTRICAL CHARACTERISTICS**

Limit specifications at  $T_A = -40$ °C to +105°C. Typical specifications at  $T_A = +25$ °C, AVDD = +5V, DVDD = +1.8V, IOVDD = +3.3V,  $f_{CLK} = 27MHz$ , VREFP = 2.5V, VREFN = 0V, and all channels active, unless otherwise noted.

			AD	S1174, ADS117	78	
PARAMETI	ER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
ANALOG INPUTS				<u>'</u>	<u> </u>	
Full-scale input voltage (FSR <sup>(1)</sup> )		$V_{IN} = (AINP - AINN)$		$\pm V_{REF}$		V
Absolute input voltage		AINP or AINN to AGND	AGND - 0.1		AVDD + 0.1	V
Common-mode input voltage		V <sub>CM</sub> = (AINP + AINN)/2		2.5		V
Differential in a disease days	High-Speed mode			28		kΩ
Differential input impedance	Low-Power mode			140		kΩ
DC PERFORMANCE						
Resolution		No missing codes	16			Bits
D-t // )	High-Speed mode			52,734		SPS
Data rate (f <sub>DATA</sub> )	Low-Power mode			10,547		SPS
Integral nonlinearity (INL)(2)		Differential input		±0.3	±1	LSB
Offset error				0.3	2	mV
Offset drift				2		μV/°C
Gain error				0.1	0.5	%
Gain drift				2		ppm/°C
Noise		Shorted input		1		LSB <sub>PP</sub>
Common-mode rejection		$f_{CM} = 60Hz^{(3)}$		100		dB
	AVDD	$f_{PS} = 60Hz^{(3)}$		75		dB
Power-supply rejection	DVDD	$f_{PS} = 60Hz^{(3)}$		85		dB
	IOVDD	$f_{PS} = 60Hz^{(3)}$		90		dB
V <sub>COM</sub> output voltage		No load		AVDD/2		V
AC PERFORMANCE						
Crosstalk		V <sub>IN</sub> = 1kHz, -0.5dBFS		-107		dB
Signal-to-noise ratio (SNR) (unwei	ghted)	V <sub>IN</sub> = 1kHz, -0.5dBFS	92	97		dB
Total harmonic distortion (THD) <sup>(4)</sup>	High-Speed mode	V <sub>IN</sub> = 1kHz, -0.5dBFS		-105	-96	dB
Spurious-free dynamic range				106		dB
Passband ripple					±0.005	dB
Passband				0.453 f <sub>DATA</sub>		Hz
–3dB Bandwidth				0.49 f <sub>DATA</sub>		Hz
Stop band attenuation			100			dB
Stop band			0.547 f <sub>DATA</sub>		63.453 f <sub>DATA</sub>	Hz
Group delay				38/f <sub>DATA</sub>		s
Settling time (latency)		Complete settling		76/f <sub>DATA</sub>		s

<sup>(1)</sup> FSR = full-scale range =  $2V_{REF}$ 

Best-fit method.

 $f_{\text{CM}}$  is the input common-mode frequency.  $f_{\text{PS}}$  is the power-supply frequency. THD includes the first nine harmonics of the input signal.



### **ELECTRICAL CHARACTERISTICS (continued)**

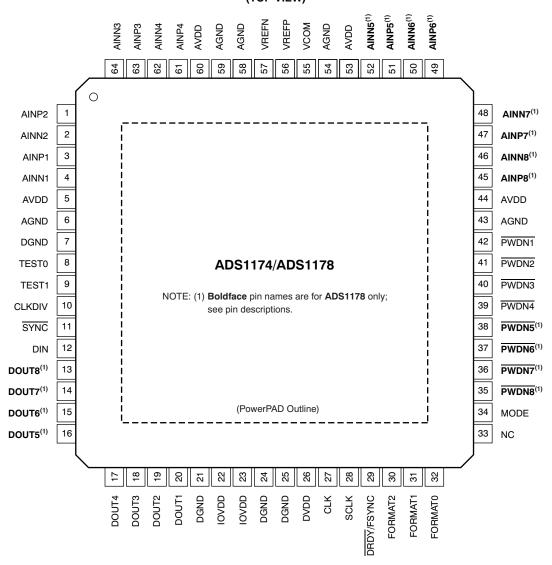
Limit specifications at  $T_A = -40$ °C to +105°C. Typical specifications at  $T_A = +25$ °C, AVDD = +5V, DVDD = +1.8V, IOVDD = +3.3V,  $f_{CLK} = 27MHz$ , VREFP = 2.5V, VREFN = 0V, and all channels active, unless otherwise noted.

			ADS1174, ADS1178			
PARAME	TER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
VOLTAGE REFERENCE INPUT	rs				T	
Reference input voltage (V <sub>REF</sub> )		V <sub>REF</sub> = VREFP - VREFN	0.5	2.5	3.1	V
Negative reference input (VREFI	N)		AGND - 0.1		AGND + 0.1	V
Positive reference input (VREFP)			VREFN + 0.5		VREFN + 3.1	V
ADS1174 Reference Input impedance	High-Speed mode			2.6		kΩ
	Low-Power mode			13		kΩ
ADS1178	High-Speed mode			1.3		kΩ
Reference Input impedance	Low-Power mode			6.5		kΩ
DIGITAL INPUT/OUTPUT (IOVE	OD = 1.8V to 3.6V)				1	
V <sub>IH</sub>			0.7 IOVDD		IOVDD	V
V <sub>IL</sub>			DGND		0.3 IOVDD	V
V <sub>OH</sub>		I <sub>OH</sub> = 4mA	0.8 IOVDD		IOVDD	V
V <sub>OL</sub>		I <sub>OL</sub> = 4mA	DGND		0.2 IOVDD	٧
Input leakage		0 < V <sub>IN DIGITAL</sub> < IOVDD			±10	μА
Master clock rate (f <sub>CLK</sub> )			0.1		27	MHz
POWER SUPPLY			-1			
AVDD			4.75	5	5.25	V
DVDD			1.65	1.8	1.95	V
IOVDD			1.65		3.6	V
	AVDD			1	10	μΑ
Power-down current	DVDD			1	15	μΑ
	IOVDD			1	10	μΑ
ADS1174			1		1	
ADS1174	High-Speed mode			23	35	mA
AVDD current	Low-Power mode			5	9	mA
ADS1174	High-Speed mode			10	15	mA
DVDD current	Low-Power mode			2.5	4.5	mA
ADS1174	High-Speed mode			0.075	0.3	mA
IOVDD current	Low-Power mode			0.02	0.15	mA
ADS1174	High-Speed mode			135	210	mW
Power dissipation	Low-Power mode			30	55	mW
ADS1178						
ADS1178	High-Speed mode			44	64	mA
AVDD current	Low-Power mode			9	14	mA
ADS1178	High-Speed mode			12	17	mA
DVDD current	Low-Power mode			3	4.5	mA
ADS1178	High-Speed mode			0.125	0.5	mA
IOVDD current	Low-Power mode			0.035	0.2	mA
ADS1178	High-Speed mode			245	355	mW
Power dissipation	Low-Power mode			50	80	mW



## **ADS1174/ADS1178 PIN ASSIGNMENTS**

#### PAP PACKAGE HTQFP-64 (TOP VIEW)



#### **ADS1174/ADS1178 PIN DESCRIPTIONS**

	PIN					
NAME	NO.	FUNCTION	DESCRIPTION			
AGND	6, 43, 54, 58, 59	Analog ground	Analog ground; connect to DGND using a single plane.			
AINP1	3	Analog input				
AINP2	1	Analog input				
AINP3	63	Analog input	ADS1178: AINP[8:1] Positive analog input, channels 8 through 1.			
AINP4	61	Analog input				
AINP5	51	Analog input	ADS1174: AINP[8:5] Connected to internal ESD rails. The inputs may float.			
AINP6	49	Analog input	AINP[4:1] Positive analog input, channels 4 through 1.			
AINP7	47	Analog input				
AINP8	45	Analog input				

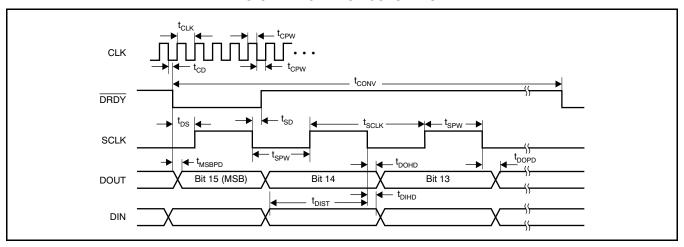


## ADS1174/ADS1178 PIN DESCRIPTIONS (continued)

NAME   NO.   All No.   Analog input   Analog input   Analog input   Analog input   All No.   2   Analog input   All No.   62   Analog input   All No.   63   Analog input   All No.   64   Analog input   All No.   65   Analog ower supply   Analog ower sup	ı	PIN		,	
AINN2   2   Analog input   AINN3   64   Analog input   AD\$1178: AINN[8:1] Negative analog input, channels 8 through 1.   AINN5   52   Analog input   AD\$1174: AINN[8:5] Connected to internal ESD rails. The inputs may float.   AINN6   50   Analog input   AVDD   5, 44, 53, 60   Analog input   AVDD   5, 44, 53, 60   Analog input   AVDD   S. 44, 53, 60   Analog input   AVDD   VCOM   55   Analog input   AVDD   VCOM   Analog over supply   ATSV   VCOM   7, 21, 24, 25   Digital input   Master clock input (maimum 27M4t2).   CLK input divider control: 1 = 27MHz   OLY   VCOM   10   Digital input   Digital oruput   DOUT1   20   Digital oruput   DOUT2   19   Digital output   DOUT3   18   Digital output   DOUT4   17   Digital output   DOUT5   15   Digital output   DOUT6   15   Digital output   DOUT6   15   Digital output   DOUT7   14   Digital output   AD\$1172: DOUT[8:1] Data output for channels 8 through 1.   DOUT6   15   Digital output   DOUT7   14   Digital output   DOUT8   15   Digital output   DOUT9   26   Digital input/cutput   AD\$1174: DOUT[8:1] Data output for channels 4 through 1.   DOUT6   15   Digital output   DOUT6   15   Digital output   DOUT7   14   Digital output   Digital output   AD\$1174: DOUT[8:1] Data output for channels 4 through 1.   DOUT6   15   Digital input   AD\$1174: DOUT[8:1] Data output for channels 4 through 1.   DOUT6   STORMATI 31   Digital input   Digital input   AD\$1174: DOUT6   STORMATI 31   Digital input   AD\$1175: DOUT6   STORMATI 31   Digital input   DOUT6   STORMATI 31   Digital input   DOUT7   AD\$1175: DOUT6   STORMATI 31   Digital input   DOUT6   STORMATI 31   Digital inp	NAME	NO.	FUNCTION	DESCRIPTION	
AINN3 64 Analog input AINN4 62 Analog input AINN5 52 Analog input AINN6 50 Analog input AINN6 50 Analog input AINN6 50 Analog input AINN6 50 Analog input AINN8 48 Analog input AINN8 46 Analog input AVDD 5, 44, 53, 60 Analog opeut AVDD 5, 44, 63, 60 Analog opeut AVDD 65 Analog opeut AVDD 7, 721, 24, 25 Digital input CLKIV 10 Digital input DOIN 10 Digital input DOIN 12 Digital input DOIN 12 Digital input DOIN 12 Digital output DOIN 13 Digital output DOIN 13 Digital output DOIN 15 Digital output DOIN 16 Digital output DOIN 17 Digital output DOIN 18 Digital output DOIN 19 Digital input DOIN 19 Digita	AINN1	4	Analog input		
AINN4 62 Analog input AINN5 52 Analog input AINN6 50 Analog input AINN7 48 Analog input AINN8 46 Analog input AINN8 46 Analog oper ANDD 5, 4,4,53,60 Analog power supply VCOM 55 Analog oper VCOM 56 Analog oper VREFN 57 Analog input CLK 27 Digital input CLK 27 Digital input CLK 27 Digital input DONT0 7, 21, 24, 25 Digital orgunt DONT1 20 Digital input DOUT2 19 Digital output DOUT3 18 Digital output DOUT4 17 Digital output DOUT5 16 Digital output DOUT5 16 Digital output DOUT6 15 Digital output DOUT7 14 Digital output DOUT7 14 Digital output DOUT8 13 Digital output DOUT9 19 Digital output DOUT9 19 Digital output DOUT6 16 Digital output DOUT7 14 Digital output DOUT7 14 Digital input DOUT7 15 Digital input DOUT8 13 Digital input DOUT9 19 Digital output DOUT9 19 Digital output DOUT9 19 Digital output DOUT1 10 Digital input DOUT6 16 Digital output DOUT7 14 Digital output DOUT7 14 Digital input DOUT6 15 Digital output DOUT7 14 Digital input DOUT7 14 Digital input DOUT8 13 Digital input DOUT9 22 23 Digital input DOUT9 26 Digital input DOUT9 27 Digital input DOUT9 28 Digital input DOUT9 29 Digital input DOUT9 20 Digital input DOUT9 30 Digital input DOUT9 40 Digital input DOUT9 41 Digital input DOUT9 42 Digital input DOUT9 43 Digital input DOUT9 44 Digital input DOUT9 45 Digital input DOUT9 46 Digital input DOUT9 47 Digital input DOUT9 48 Digital input DOUT9 49 Digital input DOUT9 40 Digital input DOUT9 40 Digital input DOUT9 50 Digital	AINN2	2	<u> </u>		
AINN4 62 Analog input AINN5 52 Analog input AINN6 50 Analog input AINN7 48 Analog input AINN8 46 Analog input AINN8 46 Analog input AINN8 46 Analog opers supply VCOM 55 Analog opers supply VCOM 55 Analog opers VREFN 57 Analog input CLK 27 Digital input CLK 27 Digital input CLK 27 Digital input DOND 7, 21, 24, 25 Digital input DONT2 19 Digital output DOUT2 19 Digital output DOUT3 18 Digital output DOUT4 17 Digital output DOUT5 16 Digital output DOUT5 16 Digital output DOUT6 15 Digital output DOUT7 14 Digital output DOUT7 14 Digital output DOUT7 14 Digital output DOUT8 13 Digital output DOUT9 19 Digital output DOUT9 19 Digital output DOUT9 19 Digital output DOUT1 20 Digital output DOUT5 16 Digital output DOUT6 15 Digital output DOUT7 14 Digital output DOUT7 14 Digital output DOUT7 14 Digital input DOUT8 13 Digital input DOUT9 29 Digital input DOUT0 20 Digital input DOUT0 21 Digital input DOUT0 22, 23 Digital input DOUT0 24 Digital input DOUT6 34 Digital input FORMAT 31 Digital input FORMAT 32 Digital input FORMAT 33 Digital input FORMAT 34 Digital input FORMAT 35 Digital input FORMAT 36 Digital input FORMAT 37 Digital input FORMAT 38 Digital	AINN3	64	Analog input	ADS1178: AINN[8:1] Negative analog input, channels 8 through 1.	
AINN6 52 Analog input AINN6 50 Analog input AINN7 48 Analog input AINN8 46 Analog input AINN8 46 Analog input AVDD 5, 44, 53, 60 Analog proput VCCM 55 Analog opens VREFP 57 Analog opens VREFP 58 Analog input CLK 27 Digital input DOUT0 10 Digital input DOUT1 20 Digital input DOUT1 20 Digital output DOUT1 20 Digital output DOUT1 21 Digital output DOUT1 27 Digital output DOUT3 18 Digital output DOUT4 17 Digital output DOUT5 16 Digital output DOUT6 15 Digital output DOUT7 14 Digital output DOUT8 13 Digital input DOUT9 26 Digital input DOUT9 27 Digital input DOUT9 28 Digital input DOUT0 29 Digital input DOUT0 30 Digital input DOUT1 31 Digital output DOUT1 31 Digital output DOUT3 13 Digital output DOUT6 15 Digital output DOUT6 15 Digital output DOUT7 14 Digital output DOUT7 14 Digital output DOUT6 15 Digital input DOUT7 14 Digital output DOUT7 14 Digital output DOUT7 14 Digital output DOUT8 13 Digital input DOUT9 26 Digital input DOUT9 27 Digital input DOUT9 28 Digital input DOUT9 29 Digital input DOUT0 20 Digital input DOUT0 20 Digital input DOUT0 21 Digital input DOUT0 22 Digital input DOUT0 25 Digital input DOUT0 26 Digital input DOUT0 27 Digital input DOUT0 28 Digital input DOUT0 29 Digital input DOUT0 20 Digital input	AINN4	62			
AINN6 50 Analog input AINN7 48 Analog input AINN8 46 Analog input AVDD 5, 44, 63, 60 Analog ower supply VCOM 55 Analog output AVDD 5, 44, 63, 60 Analog input VREFN 57 Analog input VREFP 56 Analog input VREFP 56 Analog input VREFP 57 Digital input VREFP 57 Digital input VREFP 56 Analog input VREFP 56 Analog input VREFP 56 Analog input VREFP 57 Digital input VREFP 56 Analog input VREFP 56 Analog input VREFP 56 Analog input VREFP 56 Analog input VREFP 57 Digital input VREFP 56 Analog input VREFP 56 Analog input VREFP 56 Analog input VREFP 57 Digital input DGUT 10 Digital input DGUT 70 Digital input DGUT 90 Digital input DOUT1 90 Digital output DOUT2 19 Digital output DOUT3 18 Digital output DOUT4 17 Digital output DOUT5 16 Digital output DOUT6 15 Digital output DOUT7 14 Digital output DOUT7 14 Digital output DOUT7 14 Digital output DOUT8 13 Digital input Digital output DOUT9 13 Digital input DOUT6 15 Digital input DOUT6 15 Digital input DOUT7 14 Digital output DOUT7 14 Digital output DOUT7 14 Digital output DOUT8 13 Digital input DOUT8 13 Digital input DOUT9 20 Digital input DOUT9 13 Digital input DVDD 26 Digital input DVDD 27 Digital input DVDD 28 Digital input DVDD 29 Digital input DVDD 30 Digital input DVDD 40 Digital input DVD 50 DIGITAL INPUT DVD 50 DIGITAL INPUT DVD 50 DIGIT	AINN5	52		ADS1174: AINN[8:5] Connected to internal ESD rails. The inputs may float.	
AINN8	AINN6	50	Analog input	AINN[4:1] Negative analog input, channels 4 through 1.	
AVDD         5, 44, 53, 60         Analog power supply         Analog power supply (4.75V to 5.25V).           VCOM         55         Analog output         AVDD/2 Unbuffered analog output.           VREFN         57         Analog input         Negative reference input.           VREFP         56         Analog input         Negative reference input.           CLK         27         Digital input         Master clock input (maximum 27MHz).           CLKDIV         10         Digital ground         Digital control:         1 = 27MHz.           DDND         7, 21, 24, 25         Digital ground         Digital ground power supply.         0 = 13.5MHz (high-speed) / 5.4MHz (low-power)           DDUT1         20         Digital output         DOUT1 is TDM data output (TDM mode).           DOUT2         19         Digital output         DOUT1 is TDM data output (TDM mode).           DOUT3         18         Digital output         ADS1178: DOUT[8:1] Data output for channels 8 through 1.           DOUT4         17         Digital output         ADS1178: DOUT[8:5] Internally connected to active circuitry; outputs are driven.           DOUT5         16         Digital output         DOUT4 is 10 Data output for channels 4 through 1.           DVDD         29         Digital input output power supply (House power supply (House power supply	AINN7	48	Analog input		
VCOM   55   Analog output   AVDD/2 Unbuffered analog output.	AINN8	46	Analog input		
VREFN         57         Analog input         Negative reference input.           VREFP         56         Analog input         Positive reference input.           CLK         27         Digital input         Master clock input (maximum 27MHz).           CLKDIV         10         Digital input         Master clock input (maximum 27MHz).           DCMD         7, 21, 24, 25         Digital output         Digital control input         1 = 27MHz (high-speed) / 5.4MHz (low-power)           DDUT1         20         Digital output         Doily a point output         DOUT1         20         Digital output           DOUT2         19         Digital output         DOUT4         17         Digital output         DOUT6         16         Digital output         ADS1178: DOUT[8:1] Data output for channels 8 through 1.           DOUT3         14         Digital output         DOUT6         15         Digital output         DOUT8         13         Digital output         DOUT8         13         Digital input output         DOUT9         14         Digital input output         Frame-Sync protocol: frame clock input; SPI protocol: data ready output.           DVDD         26         Digital input output point input         Frame-Sync protocol: frame clock input; SPI protocol: data ready output.         FORMAT1 output, fixed/dynamic position TDM data, and m	AVDD	5, 44, 53, 60	Analog power supply	Analog power supply (4.75V to 5.25V).	
VREFP CLK         56         Analog input CLK         Positive reference input.           CLK         27         Digital input         Master clock input (maximum 27MHz).           CLKDIV         10         Digital input         CLK input divider control: 0 = 13.5MHz (high-speed) / 5.4MHz (low-power)           DGND         7, 21, 24, 25         Digital output Digital output DIGITAL output DOUT3         Digital output Digital output DOUT3         DOUT4         20         Digital output Digital output DOUT3         DOUT4         17         Digital output Digital output DOUT5         ADS1178: DOUT[8:1] Data output for channels 8 through 1.           DOUT5         16         Digital output Digital output DOUT6         15         Digital output Digital output DOUT6         DOUT6         16         Digital output Digital output Digital output DOUT6         DOUT6         13         Digital output Digital output DOUT6         DOUT6         13         Digital output Digital output DIGITAL Digital output DOUT6         Digital output Digital output DIGITAL	VCOM	55	Analog output	AVDD/2 Unbuffered analog output.	
CLK 27 Digital input Digital input Digital input DOUT1 2 Digital input DOUT2 19 Digital output DOUT3 18 Digital output DOUT5 16 Digital output DOUT5 16 Digital output DOUT6 15 Digital output DOUT6 15 Digital output DOUT6 15 Digital output DOUT7 14 Digital output DOUT7 14 Digital input DOUT6 13 Digital input DOUT6 13 Digital input DOUT6 15 Digital output DOUT7 14 Digital output DOUT7 14 Digital output DOUT7 14 Digital input DOUT6 13 Digital output DOUT7 14 Digital output DOUT8 13 Digital input DOUT6 15 Digital output DOUT6 15 Digital output DOUT6 15 Digital output DOUT7 14 Digital output DOUT6 13 Digital output DOUT6 13 Digital input DOUT7 14 Digital input DOUT7 14 Digital input DOUT6 13 Digital input DOUT6 13 Digital input DOUT6 13 Digital input DOUT6 13 Digital input DOUT6 14 Digital input DOUT6 15 Digital input DOUT7 14 Digital input DOUT6 15 Digital input DOUT7 14 Digital input DOUT6 15 Digital input DOUT7 15 DIGITAL DOUT6 15 DOUT6 DOUT	VREFN	57	Analog input	Negative reference input.	
CLKDIV   10   Digital input   DGND   7, 21, 24, 25   Digital ground   Digital ground   Digital ground   Digital ground   Daisy-chain data input.	VREFP	56	Analog input	Positive reference input.	
DGND 7, 21, 24, 25 Digital riput Digital riput DI DIGITAL (DIGITAL	CLK	27	Digital input	Master clock input (maximum 27MHz).	
DGND 7, 21, 24, 25 Digital ground DIGITAL ground power supply.  DIGITAL ground power supply.  DIGITAL ground power supply.  DOUT1 20 Digital output DOUT2 19 Digital output 17 DOUT3 18 Digital output 17 DOUT3 18 Digital output 18 DOUT4 17 Digital output 18 DOUT5 16 Digital output 18 DOUT6 15 Digital output 19 DOUT6 15 Digital output 19 DOUT7 14 DIgital output 19 DOUT8 13 Digital output 19 DOUT8 13 Digital output 19 DOUT9 14 Digital output 19 DOUT9 14 Digital output 19 DOUT9 14 Digital output 19 DOUT9 15 Digital input 19 DOUT9 15 DIgital output 10 DOUT9 15 DIgital output 10 DOUT9 15 DIgital input 19 DOUT9 16 DOUT9 17 DOUT9 17 DIGITAL ground power supply 10 DOUT9 18 DIGITAL ground power supply 10 DOUT9 19 DIgital input 19 DOUT9 19 DIgital input 19 DOUT9 26 DIgital input 19 DIgital input 19 DOUT9 26 DIgital input 19 DIgital input 20 DIgital input 2	CI KDIV	10	Digital input		
DIN 12 Digital input Daisy-chain data input.  DOUT1 20 Digital output DOUT2 19 Digital output 19 Digital output 19 Digital output 19 DOUT3 18 Digital output 19 DOUT3 18 Digital output 19 DOUT3 18 Digital output 19 DOUT4 17 Digital output 19 DOUT5 16 Digital output 19 DOUT6 15 Digital output 19 DOUT8 13 Digital output 19 DOUT8 13 Digital output 19 DOUT8 13 Digital input 19 DOUT8 13 Digital input 19 DOUT9 29 Digital input 19 DOUT9 29 Digital input 19 DOUT9 20 Digital input 19 DIgital input 20 DIgital input					
DOUT1 20 Digital output DOUT2 19 Digital output DOUT3 18 Digital output DOUT4 17 Digital output DOUT5 16 Digital output DOUT5 16 Digital output DOUT6 15 Digital output DOUT7 14 Digital output DOUT8 13 Digital output DOUT8 13 Digital output DOUT8 13 Digital output DOUT9 29 Digital input DOUD0 26 Digital input DOUD0 26 Digital input DOUD0 27 Digital input DOUD0 27 Digital input DOUD0 28 Digital input DOUT1 30 Digital input DOUT2 30 Digital input DOUD0 20 Di			0 0		
DOUT2 19 Digital output DOUT3 18 Digital output DOUT4 17 Digital output DOUT5 16 Digital output DOUT6 15 Digital output DOUT7 14 Digital output DOUT8 13 Digital output DOUT8 13 Digital output DOUT8 13 Digital output DOUT8 13 Digital output DOUT9 29 Digital input DVDD 26 Digital input DVDD 26 Digital input FORMATO 32 Digital input FORMATO 32 Digital input FORMATO 30 Digital input DOVDD 22, 23 Digital input DVDD 24, 23 Digital input DVDD 25 Digital input DOVDD 26 Digital input FORMATO 30 Digital input DOVDD 21, 23 Digital input DIGITAL INPUT					
DOUT3 18 Digital output DOUT4 17 Digital output DOUT5 16 Digital output DOUT6 15 Digital output DOUT7 14 Digital output DOUT8 13 Digital output DOUT8 13 Digital output DOUT8 13 Digital inputoutput DOUT9 29 Digital input/output DVDD 26 Digital input DVDD 26 Digital input DVDD 27 Digital input DVDD 28 Digital input DVDD 29 Digital input DVDD 29 Digital input DVDD 20 Digital input DVD 20 Digital input DVD 20 Digital i				DOUT1 is TDM data output (TDM mode).	
DOUT4 17 Digital output DOUT5 16 Digital output DOUT6 15 Digital output DOUT7 14 Digital output DOUT8 13 Digital output DOUT9 14 Digital output DOUT9 14 Digital output DOUT9 13 Digital output DOUT9 14 Digital output DOUT9 15 Digital output DOUT9 15 Digital output DOUT9 16 Digital output DOUT9 17 Digital output DOUT9 17 Digital output DOUT9 18 Digital output DOUT9 19 Digital output DOUT9 19 Digital output DOUT9 19 Digital output DOUT9 19 Digital input DOUT					
DOUTS 16 Digital output DOUT6 15 Digital output DOUT7 14 Digital output DOUT8 13 Digital output DOUT8 13 Digital output DRDY/ ESYNC 29 Digital input DVDD 26 Digital power supply FORMAT0 32 Digital input FORMAT1 31 Digital input FORMAT2 30 Digital input DVDD 22, 23 Digital input DVDD 22, 23 Digital input DVDD 24 Digital input DOUT8 34 Digital input DYDD 25 Digital input DYDD 26 Digital input FORMAT1 31 Digital input FORMAT2 30 Digital input DYDD 22, 23 Digital input DYDD 24 Digital input DYDD 25 Digital input DYDD 26 Digital input DYDD 27 Digital input DYDD 28 Digital input DYDD 29 Digital input DYDD 29 Digital input DYDD 20 Digital input DYD 20 Di			, .	ADS1178: DOUT[8:1] Data output for channels 8 through 1.	
DOUT6 15 Digital output DOUT7 14 Digital output DOUT8 13 Digital output DOUT8 13 Digital output DOUT8 13 Digital output DOUT9 29 Digital input/output DVDD 26 Digital power supply FORMAT0 32 Digital input FORMAT1 31 Digital input FORMAT2 30 Digital input IOVDD 22, 23 Digital input IOVDD 22, 23 Digital input IOVDD 34 Digital input IOVDD 35 Digital input IOVDD 36 Digital input IOVDD 37 Digital input IOVDD 38 Digital input IOVDD 39 Digital input IOVDD 30 Digital input IOVDD 30 Digital input IOVDD 30 Digital input IOVDD 31 Digital input IOVDD 32 Digital input IOVDD 33 Digital input IOVDD 34 Digital input IOVDD 35 Digital input IOVDD 36 Digital input IOVDD 37 Digital input IOVDD 38 Digital input IOVDD 39 Digital input IOVDD 30 Digital input IOVDD 30 Digital input IOVDD 41 Digital input IOVDD 42 Digital input IOVDD 44 Digital input IOVDD 44 Digital input IOVDD 45 DIGITAL INPUT IOVDD 46 DIGITAL INPUT IOVDD 47 DIGITAL INPUT IOVDD 48 DIGI			, , ,		
DOUT7 14 Digital output DOUT8 13 Digital output DOUT8 13 Digital output DOUT8 13 Digital input/output DRDY/FSYNC 29 Digital input/output DVDD 26 Digital power supply FORMATO 32 Digital input FORMATO 31 Digital input FORMATI 31 Digital input OVDD 22, 23 Digital power supply I/O power supply (+1.65V to +1.95V).  MODE 34 Digital input IOVDD 22, 23 Digital power supply MODE: 0 = High-Speed mode 1 = Low-Power mode.  NC 33 — Internally connected to IOVDD (connect to IOVDD or leave open).  MODE: 0 = High-Speed mode 1 = Low-Power mode.  NC 33 — Internally connected to IOVDD (connect to IOVDD or leave open).  ADS1178: PWDN[8:1] Power-down control for channels 8 through 1.  PWDN3 40 Digital input PWDN3 40 Digital input PWDN3 39 Digital input PWDN5 38 Digital input PWDN6 37 Digital input PWDN6 37 Digital input PWDN7 36 Digital input PWDN8 35 Digital input PSYNC 11 Digital input PSYNC 11 Digital input PSYNC 11 Digital input TEST[1:0] Test mode select: 00 = normal operation	DOUT5	16			
DOUT8   13   Digital output	DOUT6	15	Digital output	DOOT[4.1] Data output for channels 4 through 1.	
DRDY/FSYNC         29         Digital input/output         Frame-Sync protocol: frame clock input; SPI protocol: data ready output.           DVDD         26         Digital power supply         Digital core power supply (+1.65V to +1.95V).           FORMAT0         32         Digital input         FORMAT1           FORMAT1         31         Digital input         FORMAT[2:0] Selects between Frame-Sync/SPI protocol, TDM/discrete data outputs, fixed/dynamic position TDM data, and modulator mode/normal operating mode.           IOVDD         22, 23         Digital input         MODE: 0 = High-Speed mode.           IOVDD         34         Digital input         MODE: 0 = High-Speed mode.           NC         33         —         Internally connected to IOVDD (connect to IOVDD or leave open).           PWDN1         42         Digital input         Digital input           PWDN2         41         Digital input         ADS1178: PWDN[8:1] Power-down control for channels 8 through 1.           PWDN3         30         Digital input         ADS1178: PWDN[8:5] must = 0V.           PWDN6         37         Digital input         PWDN[8:5] Power-down control for channels 4 through 1.           PWDN8         35         Digital input         PWDN[4:1] Power-down control for channels 4 through 1.           PWDN6         28         Digital input	DOUT7	14	Digital output		
FSYNC 29 Digital input/output Prame-Sync protocol: frame clock input; SPI protocol: data ready output.  DVDD 26 Digital power supply Digital core power supply (+1.65V to +1.95V).  FORMATO 32 Digital input FORMAT1 31 Digital input Digital input PORMAT2 30 Digital input Digital input DIGITAL PORMAT2 30 DIGITAL PORMAT2 PORMAT2 30 DIGITAL PORMAT2 PORMAT	DOUT8	13	Digital output		
FORMATO 32 Digital input FORMAT1 31 Digital input FORMAT2 30 Digital input IOVDD 22, 23 Digital power supply IOVDD 22, 23 Digital input  MODE 34 Digital input NC 33 — Internally connected to IOVDD (connect to IOVDD or leave open).  MODE: 0 = High-Speed mode 1 = Low-Power mode.  Internally connected to IOVDD (connect to IOVDD or leave open).  MODE WDN1 42 Digital input PWDN2 41 Digital input PWDN3 40 Digital input PWDN4 39 Digital input PWDN5 38 Digital input PWDN6 37 Digital input PWDN6 37 Digital input PWDN7 36 Digital input PWDN8 35 Digital input PWDN8 35 Digital input PWDN8 35 Digital input SCLK 28 Digital input SCLK 28 Digital input STNC 11 Digital input TEST0 8 Digital input TEST0 8 Digital input TEST1[1:0] Test mode select: 00 = normal operation		29	Digital input/output	Frame-Sync protocol: frame clock input; SPI protocol: data ready output.	
FORMAT1 31 Digital input outputs, fixed/dynamic position TDM data, and modulator mode/normal operating mode.  IOVDD 22, 23 Digital power supply I/O power supply (+1.65V to +3.6V).  MODE 34 Digital input MODE: 0 = High-Speed mode 1 = Low-Power mode.  NC 33 — Internally connected to IOVDD (connect to IOVDD or leave open).  PWDN1 42 Digital input Digital input PWDN2 41 Digital input Digital input PWDN3 40 Digital input PWDN4 39 Digital input PWDN5 38 Digital input PWDN5 38 Digital input PWDN6 37 Digital input Digital input PWDN6 37 Digital input PWDN7 36 Digital input PWDN8 35 Digital input SCLK 28 Digital input Serial clock input.  TEST0 8 Digital input TEST[1:0] Test mode select: 00 = normal operation	DVDD	26	Digital power supply	Digital core power supply (+1.65V to +1.95V).	
FORMAT1       31       Digital input mode.       outputs, fixed/dynamic position TDM datá, and modulator mode/normal operating mode.         FORMAT2       30       Digital input       I/O power supply (+1.65V to +3.6V).         MODE       34       Digital input       MODE: 0 = High-Speed mode 1 = Low-Power mode.         NC       33       —       Internally connected to IOVDD (connect to IOVDD or leave open).         PWDN1       42       Digital input       Digital input         PWDN2       41       Digital input       ADS1178: PWDN[8:1] Power-down control for channels 8 through 1.         PWDN3       40       Digital input       ADS1178: PWDN[8:5] must = 0V. PWDN[8:1] Power-down control for channels 4 through 1.         PWDN5       38       Digital input       ADS1174: PWDN[8:5] must = 0V. PWDN[4:1] Power-down control for channels 4 through 1.         PWDN8       35       Digital input       PWDN[4:1] Power-down control for channels 4 through 1.         SCLK       28       Digital input       Serial clock input.         SYNC       11       Digital input       Synchronize input (all channels).         TEST[1:0] Test mode select: 00 = normal operation	FORMAT0	32	Digital input	FORMAT[2:0] Selects between Frame-Sync/SPI protocol. TDM/discrete data	
IOVDD   22, 23   Digital input   I/O power supply (+1.65V to +3.6V).	FORMAT1	31	Digital input	outputs, fixed/dynamic position TDM data, and modulator mode/normal operating	
MODE 34 Digital input MODE: 0 = High-Speed mode 1 = Low-Power mode.  NC 33 — Internally connected to IOVDD (connect to IOVDD or leave open).  PWDN1 42 Digital input Digital input Digital input ADS1178: PWDN[8:1] Power-down control for channels 8 through 1.  PWDN3 40 Digital input PWDN4 39 Digital input PWDN5 38 Digital input PWDN5 38 Digital input PWDN6 37 Digital input PWDN7 36 Digital input PWDN7 36 Digital input PWDN8 35 Digital input SCLK 28 Digital input Scrial clock input.  SCLK 28 Digital input Synchronize input (all channels).  TESTO 8 Digital input TEST[1:0] Test mode select: 00 = normal operation	FORMAT2	30	Digital input	mode.	
NC 33 — Internally connected to IOVDD (connect to IOVDD or leave open).    PWDN1	IOVDD	22, 23	Digital power supply	I/O power supply (+1.65V to +3.6V).	
PWDN142Digital inputPWDN241Digital inputPWDN340Digital inputPWDN439Digital inputPWDN538Digital inputPWDN637Digital inputPWDN736Digital inputPWDN835Digital inputSCLK28Digital inputSYNC11Digital inputTEST08Digital input Test mode select: 00 = normal operation	MODE	34	Digital input	MODE: 0 = High-Speed mode 1 = Low-Power mode.	
PWDN2       41       Digital input         PWDN3       40       Digital input         PWDN4       39       Digital input         PWDN5       38       Digital input         PWDN6       37       Digital input         PWDN7       36       Digital input         PWDN8       35       Digital input         SCLK       28       Digital input         SYNC       11       Digital input         TEST0       8       Digital input    ADS1178: PWDN[8:1] Power-down control for channels 8 through 1.  PWDN[8:5] must = 0V. PWDN[4:1] Power-down control for channels 4 through 1.  Serial clock input. Serial clock input. Synchronize input (all channels). TEST[1:0] Test mode select: 00 = normal operation	NC	33	_	Internally connected to IOVDD (connect to IOVDD or leave open).	
PWDN3       40       Digital input       ADS1178:       PWDN[8:1] Power-down control for channels 8 through 1.         PWDN4       39       Digital input       ADS1178:       PWDN[8:1] Power-down control for channels 8 through 1.         PWDN5       38       Digital input       PWDN[8:5] must = 0V.         PWDN6       37       Digital input       PWDN[4:1] Power-down control for channels 4 through 1.         PWDN8       35       Digital input       Serial clock input.         SCLK       28       Digital input       Serial clock input.         SYNC       11       Digital input       Synchronize input (all channels).         TEST0       8       Digital input       TEST[1:0] Test mode select:       00 = normal operation	PWDN1	42	Digital input		
PWDN4       39       Digital input       ADS1174:       PWDN[8:5] must = 0V.         PWDN6       37       Digital input       PWDN[4:1] Power-down control for channels 4 through 1.         PWDN7       36       Digital input       PWDN[4:1] Power-down control for channels 4 through 1.         PWDN8       35       Digital input       Serial clock input.         SCLK       28       Digital input       Serial clock input.         SYNC       11       Digital input       Synchronize input (all channels).         TEST0       8       Digital input       TEST[1:0] Test mode select: 00 = normal operation	PWDN2	41	Digital input		
PWDN5       38       Digital input       PWDN[8:5] must = 0V.         PWDN6       37       Digital input       PWDN[4:1] Power-down control for channels 4 through 1.         PWDN7       36       Digital input       PWDN[4:1] Power-down control for channels 4 through 1.         PWDN8       35       Digital input       Serial clock input.         SCLK       28       Digital input       Synchronize input (all channels).         TEST0       8       Digital input       TEST[1:0] Test mode select: 00 = normal operation	PWDN3	40	Digital input	ADS1178: PWDN[8:1] Power-down control for channels 8 through 1.	
PWDN6     37     Digital input       PWDN7     36     Digital input       PWDN8     35     Digital input       SCLK     28     Digital input       SYNC     11     Digital input       TEST0     8     Digital input       TEST[1:0] Test mode select:     00 = normal operation	PWDN4	39	Digital input		
PWDN7         36         Digital input           PWDN8         35         Digital input           SCLK         28         Digital input         Serial clock input.           SYNC         11         Digital input         Synchronize input (all channels).           TEST0         8         Digital input         TEST[1:0] Test mode select: 00 = normal operation	PWDN5	38	Digital input		
PWDN8     35     Digital input       SCLK     28     Digital input     Serial clock input.       SYNC     11     Digital input     Synchronize input (all channels).       TEST0     8     Digital input     TEST[1:0] Test mode select: 00 = normal operation	PWDN6	37	Digital input	PWDN[4:1] Power-down control for channels 4 through 1.	
SCLK     28     Digital input     Serial clock input.       SYNC     11     Digital input     Synchronize input (all channels).       TEST0     8     Digital input     TEST[1:0] Test mode select: 00 = normal operation	PWDN7	36	Digital input		
SYNC     11     Digital input     Synchronize input (all channels).       TEST0     8     Digital input     TEST[1:0] Test mode select: 00 = normal operation	PWDN8	35	Digital input		
SYNC     11     Digital input     Synchronize input (all channels).       TEST0     8     Digital input     TEST[1:0] Test mode select: 00 = normal operation	SCLK	28	Digital input	Serial clock input.	
TEST0 8 Digital input TEST[1:0] Test mode select: 00 = normal operation					
				TEOTICO T	



#### **TIMING CHARACTERISTICS: SPI FORMAT**



#### **TIMING REQUIREMENTS: SPI FORMAT**

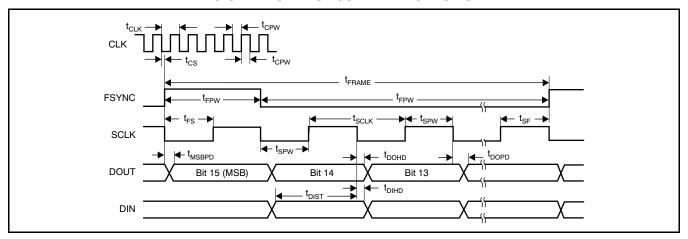
For  $T_A = -40$ °C to +105°C, IOVDD = 1.65V to 3.6V, and DVDD = 1.65V to 1.95V.

SYMBOL	PARAMETER	MIN	TYP	MAX	UNIT
t <sub>CLK</sub>	CLK period (1/f <sub>CLK</sub> ) <sup>(1)</sup>	37		10,000	ns
t <sub>CPW</sub>	CLK positive or negative pulse width	15			ns
tconv	Conversion period (1/f <sub>DATA</sub> ) <sup>(2)</sup>	256		2560	t <sub>CLK</sub>
t <sub>CD</sub> <sup>(3)</sup>	Falling edge of CLK to falling edge of DRDY		22		ns
t <sub>DS</sub> <sup>(3)</sup>	Falling edge of DRDY to rising edge of first SCLK to retrieve data	1			t <sub>CLK</sub>
MSBPD	DRDY falling edge to DOUT MSB valid (propagation delay)			16	ns
t <sub>SD</sub> (3)	Falling edge of SCLK to rising edge of DRDY		18		ns
SCLK (4)	SCLK period	1			t <sub>CLK</sub>
SPW	SCLK positive or negative pulse width	0.4			t <sub>CLK</sub>
DOHD (3) (5)	SCLK falling edge to new DOUT invalid (hold time)	10			ns
DOPD (3)	SCLK falling edge to new DOUT valid (propagation delay)			32	ns
DIST	New DIN valid to falling edge of SCLK (setup time)	6			ns
t <sub>DIHD</sub> <sup>(5)</sup>	Old DIN valid to falling edge of SCLK (hold time)	6			ns

- $f_{CLK}$  = 27MHz maximum. Depends on MODE[1:0] and CLKDIV selection. See Table 4 (f<sub>CLK</sub>/f<sub>DATA</sub>). Load on  $\overline{DRDY}$  and DOUT = 20pF.
- (4) For best performance, limit  $f_{SCLK}/f_{CLK}$  to ratios of 1, 1/2, 1/4, 1/8, etc.
- $t_{DOHD}$  (DOUT hold time) and  $t_{DIHD}$  (DIN hold time) are specified under opposite worst-case conditions (digital supply voltage and ambient temperature). Under equal conditions, with DOUT connected directly to DIN, the timing margin is >4ns.



#### TIMING CHARACTERISTICS: FRAME-SYNC FORMAT



#### TIMING REQUIREMENTS: FRAME-SYNC FORMAT

For  $T_A = -40$ °C to +105°C, IOVDD = 1.65V to 3.6V, and DVDD = 1.65V to 1.95V.

SYMBOL	PARAMETER	MIN	TYP	MAX	UNIT
t <sub>CLK</sub>	CLK period (1/f <sub>CLK</sub> )	37		10,000	ns
t <sub>CPW</sub>	CLK positive or negative pulse width	12			ns
t <sub>CS</sub>	Falling edge of CLK to falling edge of SCLK	-0.25		0.25	t <sub>CLK</sub>
t <sub>FRAME</sub>	Frame period (1/f <sub>DATA</sub> ) <sup>(1)</sup>	256		2560	$t_{CLK}$
t <sub>FPW</sub>	FSYNC positive or negative pulse width	1			t <sub>SCLK</sub>
t <sub>FS</sub>	Rising edge of FSYNC to rising edge of SCLK				ns
t <sub>SF</sub>	Rising edge of SCLK to rising edge of FSYNC				ns
t <sub>SCLK</sub>	SCLK period <sup>(2)</sup>				t <sub>CLK</sub>
t <sub>SPW</sub>	SCLK positive or negative pulse width	0.4			t <sub>CLK</sub>
t <sub>DOHD</sub> (3)(4)	SCLK falling edge to old DOUT invalid (hold time)	10			ns
t <sub>DOPD</sub> (4)	SCLK falling edge to new DOUT valid (propagation delay)			31	ns
t <sub>MSBPD</sub>	FSYNC rising edge to DOUT MSB valid (propagation delay)			31	ns
t <sub>DIST</sub>	New DIN valid to falling edge of SCLK (setup time)	6			ns
t <sub>DIHD</sub> (3)	Old DIN valid to falling edge of SCLK (hold time)	6			ns

Depends on MODE[1:0] and CLKDIV selection. See Table 4 ( $f_{CLK}/f_{DATA}$ ). SCLK must be continuously running and limited to ratios of 1, 1/2, 1/4, and 1/8 of  $f_{CLK}$ .  $t_{DOHD}$  (DOUT hold time) and  $t_{DIHD}$  (DIN hold time) are specified under opposite worst-case conditions (digital supply voltage and ambient temperature). Under equal conditions, with DOUT connected directly to DIN, the timing margin is >4ns. Load on DOUT = 20pF.



#### **OVERVIEW**

The ADS1174 (quad) and ADS1178 (octal) are 16-bit, delta-sigma ADCs. They offer the combination of excellent linearity, low noise, and low power consumption. Figure 1 shows the block diagram. Note that both devices are the same, except the ADS1174 has four ADCs, and the ADS1178 has eight ADCs. The pinout and package of the ADS1178 are compatible with the ADS1174 (and the 24-bit ADS1274 and ADS1278), permitting drop-in expandability or upgrades. The converters are comprised of either four (ADS1174) or eight (ADS1178) advanced, 6th-order, chopper-stabilized, delta-sigma modulators followed by low-ripple, linear phase FIR filters. The modulators measure the differential input signal, V<sub>IN</sub> = (AINP - AINN), against the differential reference,  $V_{REF} = (VREFP - VREFN)$ . The digital filters receive the modulator signal and provide a low-noise digital output.

To allow tradeoffs between speed and power, two modes of operation are supported: High-Speed and Low-Power. Table 1 summarizes the performance of each mode.

In High-Speed mode, the data rate is 52kSPS, and in Low-Power mode, the power dissipation is only 7mW/channel at 10.5kSPS.

The ADS1174/78 is configured by simply setting the appropriate I/O pins—there are no registers to program. Data are retrieved over a serial interface that supports both SPI and Frame-Sync formats. The ADS1174/78 has a daisy-chainable output and the ability to synchronize externally, so it can be used conveniently in systems requiring more than eight channels.

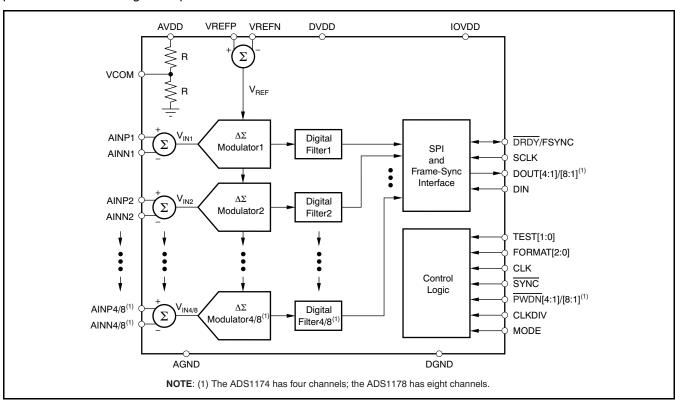


Figure 1. ADS1174/ADS1178 Block Diagram

**Table 1. Operating Mode Performance Summary** 

MODE	DATA RATE (SPS)	PASSBAND (Hz)	SNR (dB)	NOISE (LSB <sub>PP</sub> )	POWER DISSIPATION PER CHANNEL <sup>(1)</sup> (mW)
High-Speed	52,734	23,889	97	1	31
Low-Power	10,547	4,778	97	1	7

(1) Measured with all channels operating.



#### **FUNCTIONAL DESCRIPTION**

The ADS1174 and ADS1178 are 16-bit delta/sigma ADCs consisting of independent converters that digitize input signals simultaneously. The ADS1174 consists of four independent converters, while the ADS1178 has eight independent converters.

The converter is composed of two main functional blocks to perform the ADC conversions: the modulator and the digital filter. The modulator samples the input signal together with sampling the reference voltage to produce a 1's density output stream. The density of the output stream is proportional to the analog input level relative to the reference voltage. The pulse stream is filtered by the internal digital filter where the output conversion result is produced.

In operation, the signal inputs and reference inputs are sampled by the modulator at a high rate (typically 64x higher than the final output data rate). The quantization noise of the modulator is moved to a higher frequency range where the internal digital filter removes it. This process results in very low levels of noise within the signal passband.

Because the input signal is sampled at a very high rate, input signal aliasing does not occur until the input signal frequency approaches the modulator sampling rate. The high sampling rate of the modulator greatly relaxes the requirement of external antialiasing filters, thus eliminating passband phase errors that otherwise may be caused by the analog filter.

#### SAMPLING APERTURE MATCHING

The converters of the ADS1174/78 operate from the same CLK input. The CLK input controls the timing of the modulator sampling instant. The converter is designed so that the sampling skew (or modulator sampling aperture match) between channels is controlled. Furthermore, the digital filters are synchronized to start the convolution phase at the same modulator clock cycle. This design results in excellent phase match among the ADS1174/78 channels.

The phase match of one four-channel ADS1174 to that of another ADS1174 may not have the same degree of sampling match (the same is true for two 8-channel ADS1178s). As a result of manufacturing variations, differences in internal propagation delay of the internal CLK signal coupled with differences of the arrival of the external CLK signal to each device may cause larger sampling match errors. Equal length CLK traces or external clock distribution devices can be used to control the arrival of the CLK signals to help reduce the sampling match error.

#### FREQUENCY RESPONSE

The digital filter sets the overall frequency response. The filter uses a multi-stage FIR topology to provide linear phase with minimal passband ripple and high stop band attenuation. The oversampling ratio of the digital filter (that is, the ratio of the modulator sampling to the output data rate:  $f_{MOD}/f_{DATA}$ ) is 64 for both High-Speed and Low-Power modes.

Figure 2 shows the frequency response of the ADS1174/78 normalized to  $f_{DATA}$ . Figure 3 shows the passband ripple. The transition from passband to stop band is illustrated in Figure 4. The overall frequency response repeats at 64x multiples of the modulator frequency  $f_{MOD}$ , as shown in Figure 5.

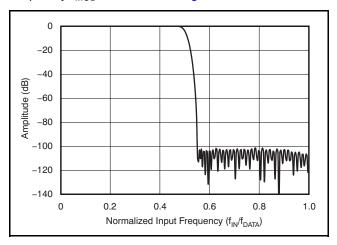


Figure 2. Frequency Response

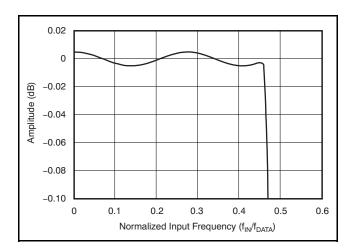


Figure 3. Passband Response



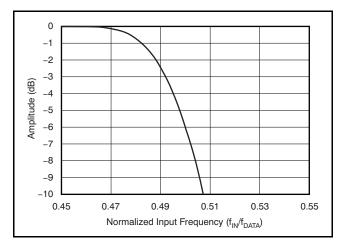


Figure 4. Transition Band Response

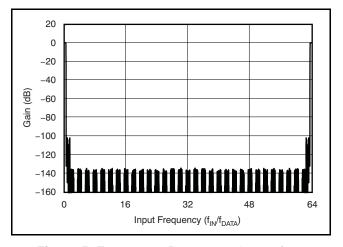


Figure 5. Frequency Response Out to f<sub>MOD</sub>

These image frequencies, if present in the signal and not externally filtered, fold back (or alias) into the passband, causing errors. Table 2 lists the degree of image rejection versus external antialiasing filter order. The stop band of the ADS1174/78 provides 100dB attenuation of frequencies that begin just beyond the passband and continue out to  $f_{\text{MOD}}$ . Placing an antialiasing, low-pass filter in front of the ADS1174/78 inputs is recommended to limit possible high-amplitude, out-of-band signals and noise.

Table 2. Antialiasing Filter Order Image Rejection

ANTIALIASING FILTER ORDER	IMAGE REJECTION (dB) (f <sub>-3dB</sub> at f <sub>DATA</sub> )
1	39
2	75
3	111

#### PHASE RESPONSE

The ADS1174/78 incorporates a multiple stage, linear phase digital filter. Linear phase filters exhibit constant delay time versus input frequency (constant group delay), which means the time delay from any instant of the input signal to the same instant of the output data is constant, and is independent of input signal frequency. This behavior results in essentially zero phase errors when analyzing multi-tone signals.

#### **SETTLING TIME**

As with frequency and phase response, the digital filter also determines settling time. Figure 6 shows the output settling behavior after a step change on the analog inputs normalized to conversion periods. The X-axis is given in units of conversion. Note that after the step change on the input occurs, the output data change very little prior to 30 conversion periods. The output data are fully settled after 76 conversion periods.

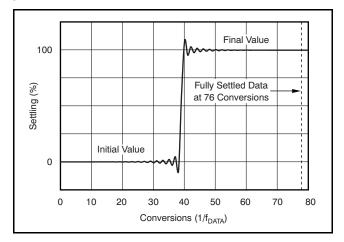


Figure 6. Step Response

#### **ANALOG INPUTS (AINP, AINN)**

The ADS1174/78 measures each differential input signal  $V_{\rm IN} = ({\sf AINP} - {\sf AINN})$  against the common differential reference  $V_{\rm REF} = ({\sf VREFP} - {\sf VREFN})$ . The most positive measurable differential input is  $+V_{\rm REF}$ , which produces the most positive digital output code of 7FFFh. Likewise, the most negative measurable differential input is  $-V_{\rm REF}$ , which produces the most negative digital output code of 8000h.

For optimal performance, drive the ADS1174/78 inputs differentially. For single-ended input applications, one of the inputs (AINP or AINN) can be driven while the other input is fixed (typically, to AGND or +2.5V); fixing the input to +2.5V permits bipolar operation, thereby using the full range of the converter.



While the ADS1174/78 measures the differential input signal, the absolute input voltage is also important. This is the voltage on either input (AINP or AINN) with respect to AGND. The range for this voltage is:

$$-0.1V < (AINN or AINP) < AVDD + 0.1V$$

If either input is taken below -0.4V or above (AVDD + 0.4), ESD protection diodes on the inputs may turn on.

If these conditions are possible, external Schottky clamp diodes or series resistors may be required to limit the input current to safe levels (see Absolute Maximum Ratings table).

The ADS1174/78 is a high-performance ADC. For optimum performance, it is critical that the appropriate circuitry be used to drive the ADS1174/78 inputs. See the *Applications Information* section for the recommended circuits.

The ADS1174/78 uses switched-capacitor circuitry to measure the input voltage. Internal capacitors are charged by the inputs and then discharged. Figure 7 shows a conceptual diagram of these circuits. Switch  $S_2$  represents the net effect of the modulator circuitry in discharging the sampling capacitor; the actual implementation is different. The timing for switches  $S_1$  and  $S_2$  is shown in Figure 8. The sampling time  $(t_{\text{SAMPLE}})$  is the inverse of modulator sampling frequency  $(f_{\text{MOD}})$  and is a function of the mode, the CLKDIV input, and frequency of CLK, as shown in Table 3.

The average load presented by the switched capacitor input can be modeled with an effective differential impedance, as shown in Figure 9. Note that the effective impedance is a function of  $f_{\text{MOD}}$ .

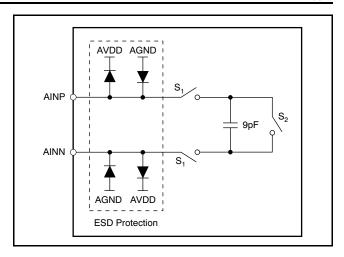


Figure 7. Equivalent Analog Input Circuitry

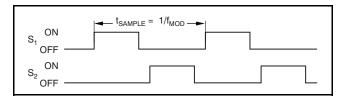


Figure 8. S<sub>1</sub> and S<sub>2</sub> Switch Timing for Figure 7

Table 3. Modulator Frequency (f<sub>MOD</sub>) versus Mode Selection

MODE SELECTION	CLKDIV	f <sub>MOD</sub>
Lligh Coood	1	f <sub>CLK</sub> /8
High-Speed	0	f <sub>CLK</sub> /4
Low-Power	1	f <sub>CLK</sub> /40
Low-Power	0	f <sub>CLK</sub> /8

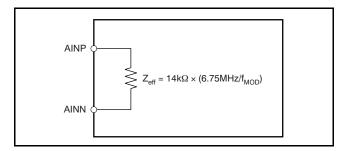


Figure 9. Effective Input Impedances



# VOLTAGE REFERENCE INPUTS (VREFP, VREFN)

The voltage reference for the ADS1174/78 ADC is the differential voltage between VREFP and VREFN:  $V_{REF} = (VREFP - VREFN)$ . The voltage reference is common to all channels. The reference inputs use a structure similar to that of the analog inputs with the equivalent circuitry on the reference inputs shown in Figure 10. As with the analog inputs, the load presented by the switched capacitor can be modeled with an effective impedance, as shown in Figure 11. However, the reference input impedance depends on the number of active (enabled) channels in addition to f<sub>MOD</sub>. As a result of the change of reference input impedance caused by enabling and disabling channels, the regulation and settling time of the external reference should be noted, so as not to affect the readings of other channels.

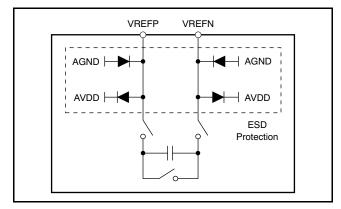


Figure 10. Equivalent Reference Input Circuitry

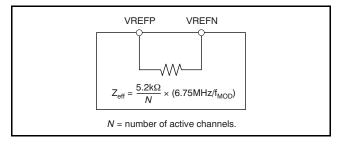


Figure 11. Effective Reference Impedance

ESD diodes protect the reference inputs. To keep these diodes from turning on, make sure the voltages on the reference pins do not go below AGND by more than 0.4V, and likewise do not exceed AVDD by 0.4V.

If these conditions are possible, external Schottky clamp diodes or series resistors may be required to limit the input current to safe levels (see Absolute Maximum Ratings table).

Note that the valid operating range of the reference inputs is limited to the following:

 $-0.1V \le VREFN \le 0.1V$ 

VREFN + 0.5V ≤ VREFP ≤ VREFN + 3.1V

A high-quality reference voltage with the appropriate drive strength is essential for achieving the best performance from the ADS1174/78. Noise and drift on the reference degrade overall system performance. See the *Application Information* section for example reference circuits.

#### **CLOCK INPUT (CLK)**

The ADS1174/78 requires a clock input for operation. Each ADS1174/78 converter operates from the same clock input. At the maximum data rate, the clock input can be either 27MHz or 13.5MHz (5.4MHz, low-power mode), determined by the setting of the CLKDIV input. The selection of the external clock frequency (f<sub>CLK</sub>) does not affect the resolution (the oversampling ratio, OSR, remains fixed) or power dissipation of the ADS1174/78. However, a slower f<sub>CLK</sub> can reduce the power consumption of an external clock driver. The output data rate scales with clock frequency, down to a minimum clock frequency of f<sub>CLK</sub> = 100kHz. Table 4 summarizes the ratio of clock input frequency (f<sub>CLK</sub>) to (f<sub>DATA</sub>), maximum data rate and rate corresponding maximum clock input for the two operating modes.

**Table 4. Clock Input Options** 

MODE SELECTION	f <sub>CLK</sub> (MHz)	CLKDIV	f <sub>CLK</sub> /f <sub>DATA</sub>	DATA RATE (SPS)
High Chood	27	1	512	52,734
High-Speed	13.5	0	256	52,754
Low-Power	27	1	2,560	10.547
Low-Power	5.4	0	512	10,547

As with any high-speed data converter, a high-quality, low-jitter clock is essential for optimum performance. Crystal clock oscillators are the recommended clock source. Make sure to avoid excess ringing on the clock input; keeping the clock trace as short as possible using a  $50\Omega$  series resistor, placed close to the source end, often helps.



#### MODE SELECTION (MODE)

The ADS1174/78 supports two modes of operation: High-Speed and Low-Power. These modes offer optimization of speed and power. The mode selection is determined by the status of the digital input MODE pins, as shown in Table 5. The ADS1174/78 constantly monitors the status of the MODE pin during operation.

**Table 5. Mode Selection** 

MODE	MODE SELECTION	MAX f <sub>DATA</sub> <sup>(1)</sup>
0	High-Speed	52,734
1	Low-Power	10,547

(1)  $f_{CLK} = 27MHz$  (CLKDIV = 1).

When using the SPI protocol,  $\overline{DRDY}$  is held high after a mode change occurs until settled (or valid) data are ready, as shown in Figure 12 and Table 6.

In Frame-Sync protocol, the DOUT pins are held low after a mode change occurs until settled data are ready, as shown in Figure 12 and Table 6. Data can be read from the device to detect when DOUT changes to logic 1, indicating valid data.

## SYNCHRONIZATION (SYNC)

The ADS1174/78 can be synchronized by pulsing the SYNC pin low and then returning the pin high. When the pin goes low, the conversion process stops, and the internal counters used by the digital filter are reset. When the SYNC pin returns high, the conversion process restarts. Synchronization allows the conversion to be aligned with an external event, such as a reference timing pulse.

Since the converters of the ADS1174/78 operate in parallel from the same master clock and use the same SYNC input control, they are, by default, in synchronization with each other. However, the synchronization of multiple ADS1174/78s is somewhat different. At device power-on, variations in internal reset thresholds from device to device may result in uncertainty in conversion timing.

The SYNC pin can be used to synchronize multiple ADS1174/78s to within the same CLK cycle. Figure 13 illustrates the timing requirement of SYNC and CLK in SPI format.

See Figure 14 for the Frame-Sync format timing requirement.

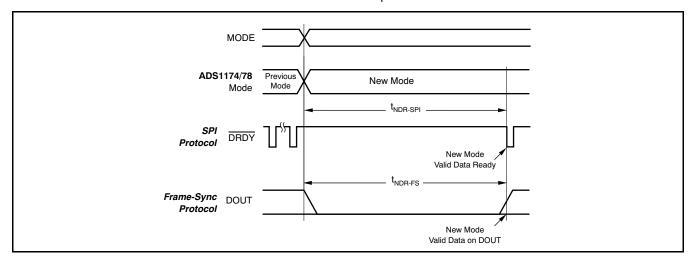


Figure 12. Mode Change Timing

#### **Table 6. Mode Change**

SYMBOL	DESCRIPTION	MIN	TYP	MAX	UNITS
t <sub>NDR-SPI</sub>	Time for new data to be ready (SPI)			129	Conversions (1/f <sub>DATA</sub> )
t <sub>NDR-FS</sub>	Time for new data to be ready (Frame-Sync)	127		128	Conversions (1/f <sub>DATA</sub> )



After synchronization, indication of valid data depends on the whether SPI or Frame-Sync format is used.

In the SPI format,  $\overline{DRDY}$  goes high as soon as  $\overline{SYNC}$  is taken low; see Figure 13. After  $\overline{SYNC}$  is returned high,  $\overline{DRDY}$  stays high while the digital filter is settling. Once valid data are ready for retrieval,  $\overline{DRDY}$  goes low.

In the Frame-Sync format, DOUT goes low <u>as soon</u> as <u>SYNC</u> is taken low; see <u>Figure 14</u>. After <u>SYNC</u> is returned high, DOUT stays low while the digital filter is settling. Once valid data are ready for retrieval, DOUT begins to output valid data. For proper synchronization, <u>FSYNC</u>, <u>SCLK</u>, and CLK must be established before taking <u>SYNC</u> high, and must then remain running.

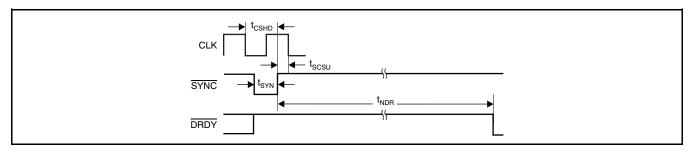


Figure 13. Synchronization Timing for SPI Protocol

**Table 7. SPI Protocol** 

SYMBOL	DESCRIPTION	MIN	TYP	MAX	UNITS
t <sub>CSHD</sub>	CLK to SYNC hold time (to not latch on CLK edge)	10			ns
t <sub>SCSU</sub>	SYNC to CLK setup time (to latch on CLK edge)	5			ns
t <sub>SYN</sub>	Synchronize pulse width	1			CLK periods
t <sub>NDR</sub>	Time for new data to be ready			129	Conversions (1/f <sub>DATA</sub> )

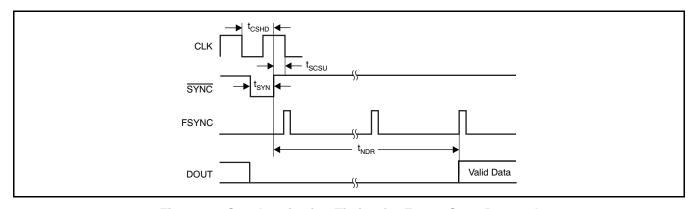


Figure 14. Synchronization Timing for Frame-Sync Protocol

**Table 8. Frame-Sync Protocol** 

SYMBOL	DESCRIPTION	MIN	TYP	MAX	UNITS
t <sub>CSHD</sub>	CLK to SYNC hold time (to not latch on CLK edge)	10			ns
t <sub>SCSU</sub>	SYNC to CLK setup time (to latch on CLK edge)	5			ns
t <sub>SYN</sub>	Synchronize pulse width	1			CLK periods
t <sub>NDR</sub>	Time for new data to be ready	127		128	Conversions (1/f <sub>DATA</sub> )

Copyright © 2007–2008, Texas Instruments Incorporated

Submit Documentation Feedback



#### POWER-DOWN (PWDN)

The ADS1174/78 measurement channels can be independently powered down by use of the  $\overline{PWDN}$  inputs. To enter the power-down mode, hold the respective PWDN pin low for at least two  $f_{CLK}$  cycles. To exit power-down, return the corresponding PWDN pin high. Note that when all channels are powered down, the ADS1174/78 enters a microwatt ( $\mu W$ ) power state where all internal biasing is powered down. In this event, the TEST[1:0] input pins must be driven; all other input pins can float (the ADS1174/78 outputs remain driven).

As shown in Figure 15 and Table 9, a maximum of 130 conversion cycles (SPI interface) or 129 conversion cycles (Frame-Sync interface) must elapse before reading data after exiting power-down. Data from channels already running are not affected. The user software can perform the required delay time in the following ways:

1. Count the number of data conversions after taking the PWDN pin high.

- Wait for 130/f<sub>DATA</sub> (SPI) or 129/f<sub>DATA</sub> (Frame-Sync) after taking the PWDN pins high.
- Detect for non-zero data in the powered-up channel.

After powering up one or more channels, the channels are synchronized to each other. It is not necessary to use the SYNC pin to synchronize them.

When a channel is powered down in TDM data format, the data for the powered-down channel are either forced to zero (fixed-position TDM data mode) or replaced by shifting the data from the next channel into the vacated data position (dynamic-position TDM data mode).

In discrete data format, the data are always forced to zero. When powering-up a channel in dynamic-position TDM data format mode, the channel data remain packed until the data are ready, at which time the data frame is expanded to include the just-powered channel data. See the *Data Format* section for details.

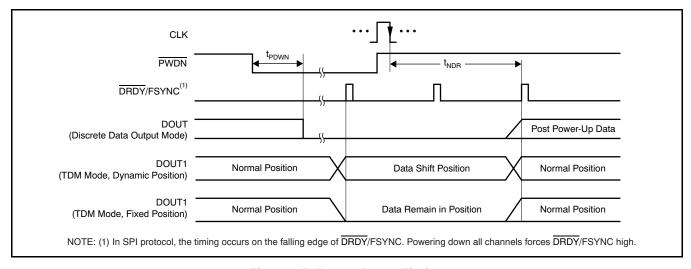


Figure 15. Power-Down Timing

**Table 9. Power-Down Timing** 

SYMBOL	DESCRIPTION	MIN	TYP	MAX	UNITS
t <sub>PDWN</sub>	PDWN pulse width to enter Power-Down mode	2			CLK periods
4	Time for new data to be ready (SPI)	129		130	Conversions (1/f <sub>DATA</sub> )
<sup>I</sup> NDR	Time for new data to be ready (Frame-Sync)	128		129	Conversions (1/f <sub>DATA</sub> )



#### FORMAT[2:0]

Data can be read from the ADS1174/78 with two serial interface protocols (SPI or Frame-Sync) and several options of data formats (TDM/Discrete and Fixed/Dynamic data positions). The FORMAT[2:0] inputs are used to select among the options. Table 10 lists the available options. See the DOUT Modes section for details of the DOUT modes and data positions.

**Table 10. Data Output Format** 

FORMAT[2:0]	INTERFACE PROTOCOL	DOUT MODE	DATA POSITION
000	SPI	TDM	Dynamic
001	SPI	TDM	Fixed
010	SPI	Discrete	_
011	Frame-Sync	TDM	Dynamic
100	Frame-Sync	TDM	Fixed
101	Frame-Sync	Discrete	_

#### **DATA FORMAT**

The ADS1174/78 outputs 16 bits of data in two's complement format.

A positive full-scale input produces an ideal output code of 7FFFh, and the negative full-scale input produces an ideal output code of 8000h. The output clips at these codes for signals exceeding full-scale. Table 11 summarizes the ideal output codes for different input signals.

Table 11. Ideal Output Code versus Input Signal

INPUT SIGNAL V <sub>IN</sub> (AINP – AINN)	IDEAL OUTPUT CODE <sup>(1)</sup>
≥ +V <sub>REF</sub>	7FFFh
+ V <sub>REF</sub> 2 <sup>15</sup> - 1	0001h
0	0000h
$\frac{-V_{REF}}{2^{15}-1}$	FFFFh
$\leq -V_{REF} \left( \frac{2^{15}}{2^{15} - 1} \right)$	8000h

<sup>(1)</sup> Excludes effects of noise, INL, offset, and gain errors.

#### SERIAL INTERFACE PROTOCOLS

Data are retrieved from the ADS1174/78 using the serial interface. Two protocols are available: SPI and Frame-Sync. The <u>same</u> pins are used for both interfaces: SCLK, DRDY/FSYNC, DOUT[4:1] (or DOUT[8:1] for the ADS1178), and DIN. The FORMAT[2:0] pins select the desired interface protocol.

#### SPI SERIAL INTERFACE

The SPI-compatible format is a simple read-only interface. Data ready for retrieval are indicated by the falling DRDY output and are shifted out on the falling edge of SCLK, MSB first. The interface can be daisy-chained using the DIN input when using multiple ADS1174/78s. See the *Daisy-Chaining* section for more information.

#### **SCLK**

The serial clock (SCLK) features a Schmitt-triggered input and shifts out data on DOUT on the falling edge. It also shifts in data on the falling edge on DIN when this pin is being used for daisy-chaining. The device shifts data out on the falling edge and the user typically shifts this data in on the rising edge. Even though the SCLK input has hysteresis, it is recommended to keep SCLK as clean as possible to prevent glitches from accidentally shifting the data. SCLK may be run as fast as the CLK frequency. SCLK may be either in free-running or stop-clock conversions. For operation between performance, use  $f_{SCLK}/f_{CLK}$  ratios of 1, 1/2, 1/4, 1/8, etc. NOTE: One CLK period is required after DRDY falls, to start shifting data (see Timing Requirements: SPI Format).

#### **DRDY/FSYNC (SPI Format)**

In the SPI format, this pin functions as the  $\overline{DRDY}$  output. It goes low when data are ready for retrieval and then returns high on the falling edge of the first subsequent SCLK. If data are not retrieved (that is, SCLK is held low),  $\overline{DRDY}$  pulses high just before the next conversion data are ready, as shown in Figure 16. The new data are loaded within one CLK cycle before  $\overline{DRDY}$  goes low. All data must be shifted out before this time to avoid being overwritten.

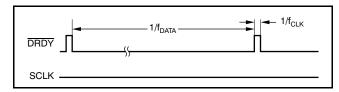


Figure 16. DRDY Timing with No Readback



#### **DOUT**

In Discrete Data Output mode, the conversion data are output on the individual DOUT pins (DOUT1, DOUT2, etc.), whereas in TDM mode, data are output only on DOUT1. The MSB data are valid on DOUT[4:1]/[8:1] when DRDY goes low. The subsequent bits are shifted out with each falling edge of SCLK. If daisy-chaining (TDM mode), the data shifted in using DIN appear on DOUT1 after all channel data have been shifted out.

#### DIN

This input is used when multiple ADS1174/78s are to be daisy-chained together. The DOUT1 pin of the first device connects to the DIN pin of the next, etc. It can be used with either the SPI or Frame-Sync formats. Data are shifted in on the falling edge of SCLK. When using only one ADS1174/78, tie DIN low. See the Daisy-Chaining section for more information.

#### FRAME-SYNC SERIAL INTERFACE

Frame-Sync format is similar to the interface often used on audio ADCs. It operates in slave fashion—the user must supply framing signal FSYNC (similar to the *left/right clock* on stereo audio ADCs) and the serial clock SCLK (similar to the *bit clock* on audio ADCs). The data is output MSB first or *left-justified*. When using Frame-Sync format, the FSYNC and SCLK inputs must be continuously running with the required relationships shown in the Frame-Sync Timing Requirements.

#### **SCLK**

The serial clock (SCLK) features a Schmitt-triggered input and shifts out data on DOUT on the falling edge. It also shifts in data on the falling edge on DIN when this pin is being used for daisy-chaining. Even though SCLK has hysteresis, it is recommended to keep SCLK as clean as possible to prevent glitches from accidentally shifting the data. When using Frame-Sync format, SCLK must run continuously; if SCLK is disabled or interrupted, the data readback

will be corrupted. The number of SCLKs within a frame period (FSYNC clock) can be any power of two ratio of clock cycles (1, 1/2, 1/4, etc.), as long as the number of cycles is sufficient to shift the data output from all channels within one data frame.

#### **DRDY/FSYNC** (Frame-Sync Format)

In Frame-Sync format, this pin is used as the FSYNC input. The frame-sync input (FSYNC) sets the frame period which must be same as the data rate. The required number of  $f_{CLK}$  cycles to each FSYNC period depends on the mode selection and the CLKDIN input. Table 4 indicates the number of CLK cycles to each frame ( $f_{CLK}/f_{DATA}$ ). If the FSYNC period is not the proper value, data readback is corrupted.

#### **DOUT**

In Discrete Data Output mode, the conversion data are shifted out on the individual DOUT pins (DOUT1, DOUT2, etc.), whereas in TDM mode, data are output only on DOUT1. The MSB data become valid on DOUT[4:1]/[8:1] on the SCLK rising edge prior to FSYNC going high. The subsequent bits are shifted out with each falling edge of SCLK. If daisy-chaining (TDM mode), the data shifted in using DIN appear on DOUT1 after all channel data have been shifted out (that is, 4 channels × 16 bits per channel = 64 bits for the ADS1174, and 8 channels × 16 bits per channel = 128 bits for the ADS1178).

#### DIN

This input is used when multiple ADS1174/78s are to be daisy-chained together. It can be used with either SPI or Frame-Sync formats. Data are shifted in on the falling edge of SCLK. When using only one ADS1174/78, tie DIN low. See the *Daisy-Chaining* section for more information.



#### **DOUT MODES**

For both SPI and Frame-Sync interface protocols, either the data are shifted out through individual channel DOUT pins in a parallel data format (Discrete mode), or the data for all channels are shifted out in series through common pin DOUT1 (TDM mode).

#### **TDM Mode**

In time division multiplexed (TDM) data output mode, the data for all channels are shifted out, in series, on a single pin (DOUT1). As shown in Figure 17, the data from channel 1 are shifted out first, followed by channel 2 data, etc. After the data from the last channel are shifted out (channel 4 for the ADS1174 or channel 8 for the ADS1178), the data from the DIN input follow. DIN is used to daisy-chain the data

output from another ADS1174, ADS1178, or other compatible device. Note that when all channels of the ADS1174/78 are powered down, the interface is powered down, rendering the DIN input powered down as well. When one or more channels of the device are powered down, the data format of the TDM mode can be fixed or dynamic.

#### TDM Mode, Fixed-Position Data

In this TDM data output mode, the data position of the channels remains fixed, regardless of whether channels are disabled. If a channel is powered down, data are forced to zero, but occupy the same position within the data stream. Figure 18 shows the data stream with channel 1 and channel 3 powered down.

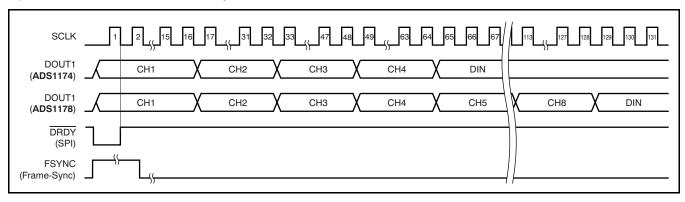


Figure 17. TDM Mode (All Channels Enabled)

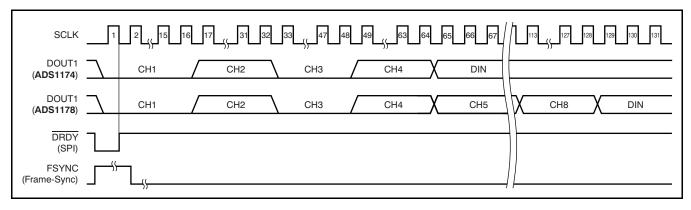


Figure 18. TDM Mode, Fixed-Position Data (Channels 1 and 3 Shown Powered Down)



#### **TDM Mode, Dynamic Position Data**

In this TDM data output mode, when a channel is powered down, the data from higher channels shift one position in the data stream to fill the vacated data slot. Figure 19 shows the data stream with channel 1 and channel 3 powered down.

#### **Discrete Data Output Mode**

In Discrete data output mode, the channel data are shifted out in parallel using individual channel data output pins DOUT[4:1] for the ADS1174, or DOUT[8:1] for the ADS1178. After the 16th SCLK, the channel data are forced to zero. The data are also forced to zero for powered-down channels. Figure 20 depicts the data format.

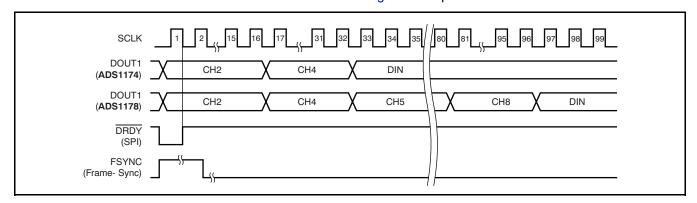


Figure 19. TDM Mode, Dynamic Position Data (Channels 1 and 3 Shown powered Down)

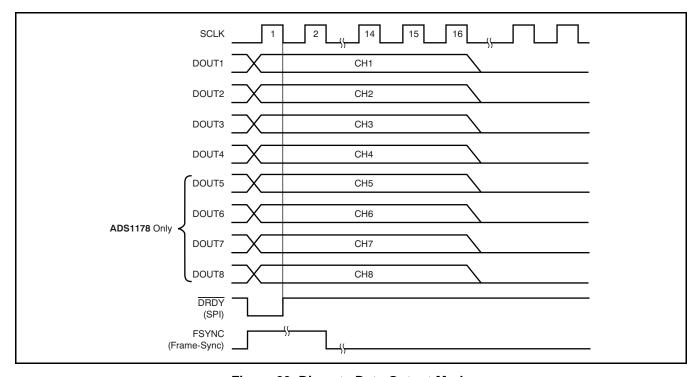


Figure 20. Discrete Data Output Mode



#### **DAISY-CHAINING**

Multiple ADS1174/78s can be daisy-chained together to simplify the serial interface connections. The DOUT1 data output pin of one ADS1174/78 is connected to the DIN input of the next ADS1174/78. As Figure 21 illustrates, the DOUT1 pin of device 1 provides the output data to a controller, and the DIN input of device 2 is grounded. Figure 22 describes the data format when reading data back in a daisy-chain configuration.

The maximum number of channels that may be daisy-chained in this way is limited by the frequency of  $f_{SCLK}$ , the mode selection, and the CLKDIV input. The frequency of  $f_{SCLK}$  must be high enough to completely shift the data out from all channels within one  $f_{DATA}$  period. Table 12 lists the maximum number of daisy-chained channels when  $f_{SCLK} = f_{CLK}$ .

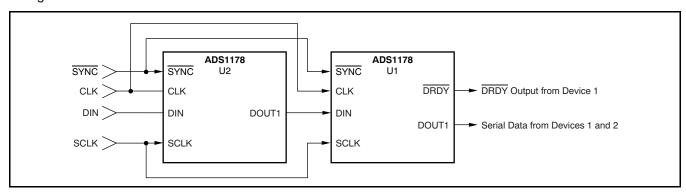


Figure 21. Daisy-Chaining of Two ADS1178s, SPI Protocol (FORMAT[2:0] = 000 or 001)

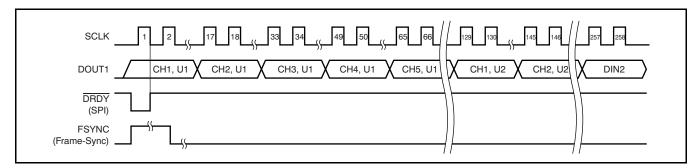


Figure 22. Daisy-Chain Data Format of Figure 21

Table 12. Maximum Channels in a Daisy-Chain ( $f_{SCLK} = f_{CLK}$ )

MODE SELECTION	CLKDIV	MAXIMUM NUMBER OF CHANNELS
High Speed	1	32
High-Speed	0	16
Low Power	1	160
Low-Power	0	32



To increase the number of data channels possible in a chain, a segmented DOUT scheme may be used, producing two data streams. Figure 23 illustrates four ADS1178s, with a pair of ADS1178s daisy-chained together. The channel data of each daisy-chained pair are shifted out in parallel and are received by the processor through independent data channels.

Whether the interface protocol is SPI or Frame-Sync, it is recommended to synchronize all devices by tying the SYNC inputs together. When synchronized in SPI protocol, it is only necessary to monitor the DRDY output of one ADS1178.

In Frame-Sync interface protocol, the data from all devices are ready on the rising edge of FSYNC.

Since DOUT1 and DIN are both shifted on the falling edge of SCLK, the propagation delay on DOUT1 creates a setup time for DIN. Minimize the skew in SCLK to avoid timing violations.

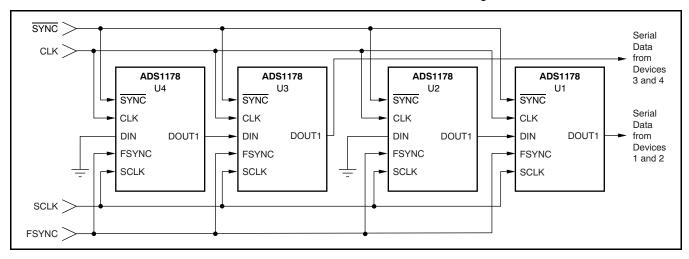


Figure 23. Segmented DOUT Daisy-Chain, Frame-Sync Protocol (FORMAT[2:0] = 011 or 100)

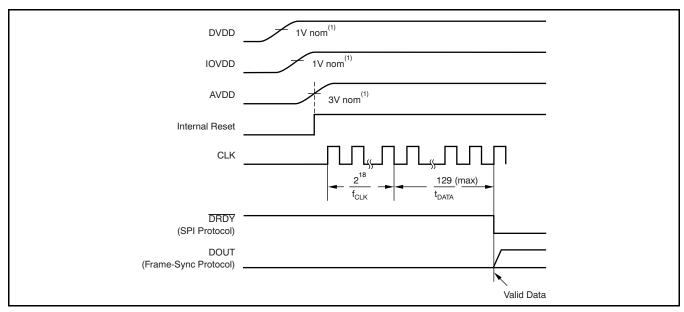


#### **POWER SUPPLIES**

The ADS1174/78 has three power supplies: AVDD, DVDD, and IOVDD. AVDD is the analog supply that powers the modulator, DVDD is the digital supply that powers the digital core, and IOVDD is the digital I/O power supply. The IOVDD and DVDD power supplies can be tied together if desired (+1.8V). To achieve rated performance, it is critical that the power supplies are bypassed with  $0.1\mu F$  and  $10\mu F$  capacitors placed as close as possible to the supply pins. A single  $10\mu F$  ceramic capacitor may be substituted in place of the two capacitors.

Figure 24 shows the start-up sequence of the ADS1174/78. At power-on, bring up the DVDD supply first, followed by IOVDD and then AVDD. Check the power-supply sequence for proper order, including the ramp rate of each supply. DVDD and IOVDD may

be sequenced at the same time if the supplies are tied together. Each supply has an internal reset circuit whose outputs are summed together to generate a global power-on reset. After the supplies have exceeded the reset thresholds, 2<sup>18</sup> f<sub>CLK</sub> cycles are counted before the converter initiates the conversion process. Following the CLK cycles, the data for 129 conversions are suppressed by the ADS1174/78 to allow output of fully-settled data. In SPI protocol, DRDY is held high during this interval. In frame-sync protocol, DOUT is forced to zero. The power supplies should be applied before any analog or digital pin is driven. For consistent performance, assert SYNC after device power-on when data first appear.



(1) The power-supply reset thresholds are approximate.

Figure 24. Start-Up Sequence



### PIN TEST USING TEST[1:0] INPUTS

Test mode allows continuity testing of the digital I/O pins. In this mode, the normal functions of the digital pins are disabled and routed to each other as pairs through internal logic, as shown in Table 13. Note that some of the digital input pins become outputs; this configuration should be taken into account when using test mode.

Table 13. Test Mode Pin Map (TEST[1:0] = 11)

TEST MODE PIN MAP(1)									
INPUT PINS	OUTPUT PINS								
PWDN1	DOUT1								
PWDN2	DOUT2								
PWDN3	DOUT3								
PWDN4	DOUT4								
PWDN5 (2)	DOUT5 <sup>(2)</sup>								
PWDN6 (2)	DOUT6 <sup>(2)</sup>								
PWDN7 (2)	DOUT7 <sup>(2)</sup>								
PWDN8 (2)	DOUT8 <sup>(2)</sup>								
MODE	DIN								
FORMAT0	CLKDIV								
FORMAT1	DRDY/FSYNC								
FORMAT2	SCLK								

The CLK input does not have a test output; SYNC = 1 and is an output.

The analog input, power supply, and ground pins remain connected as normal. The test mode is engaged by the setting the pins TEST[1:0] = 11. For normal converter operation, set TEST[1:0] = 00.

#### **VCOM OUTPUT**

The VCOM pin is an analog output of approximately AVDD/2. This voltage may be used to set the common-mode voltage of the input buffers. The drive capability of this output is limited; most cases require an external buffer to minimize loading. A  $0.1\mu F$  capacitor to AGND is recommended to reduce noise pick-up.

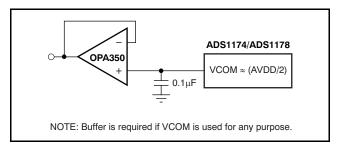


Figure 25. VCOM Output

<sup>(2)</sup> ADS1178 only.



#### APPLICATION INFORMATION

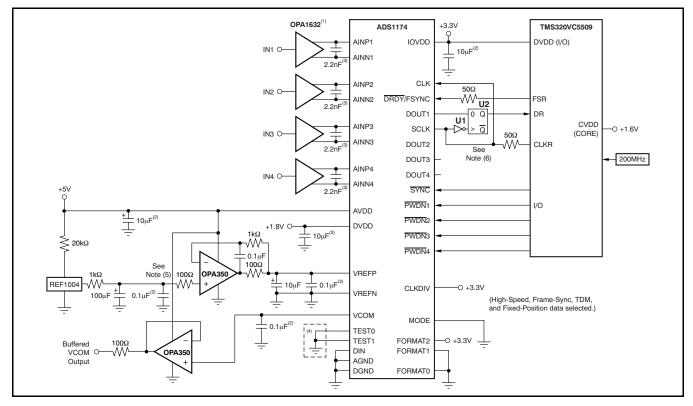
To obtain the specified performance from the ADS1174/78, the following layout and component guidelines should be considered.

- 1. Power Supplies: The device requires three power supplies for operation: DVDD, IOVDD, and AVDD. The range for DVDD is 1.65V to 1.95V; the range of IOVDD is 1.65V to 3.6V; and AVDD is restricted to 4.75V to 5.25V. For all supplies, use a 10μF tantalum capacitor, bypassed with a 0.1μF ceramic capacitor, placed close to the device pins. Alternatively, a single 10μF ceramic capacitor can be used. The supplies should be relatively free of noise and should not be shared with devices that produce voltage spikes (such as relays, LED display drivers, etc.). If a switching power-supply source is used, the voltage ripple should be low (< 2mV) and the switching frequency outside the passband of the converter.</p>
- Ground Plane: A single ground plane connecting both AGND and DGND pins can be used. If separate digital and analog grounds are used, connect the grounds together at the converter, or at the power entry point of the printed circuit board (PCB).
- 3. **Digital Inputs:** It is recommended to source-terminate the digital inputs to the device with  $50\Omega$  series resistors. The resistors should be placed close to the driving end of the digital source (oscillator, logic gates, DSP, etc.) This placement helps to reduce ringing on the digital lines, which may lead to degraded ADC performance.
- 4. Analog/Digital Circuits: Place analog circuitry (input buffer, reference) and associated tracks together, keeping them away from digital circuitry (DSP, microcontroller, logic). Avoid crossing digital tracks across analog tracks to reduce noise coupling and crosstalk.

- 5. **Reference Inputs:** It is recommended to use either a minimum  $10\mu\text{F}$  tantalum with a  $0.1\mu\text{F}$  ceramic capacitor, or a single  $1\mu\text{F}$  ceramic capacitor, directly across the reference inputs, VREFP and VREFN. The reference input should be driven by a low-impedance source. For best performance, the reference should be low-noise.
- 6. Analog Inputs: The analog input pins must be driven differentially to achieve specified performance. A true differential driver or transformer (for ac applications) can be used for this purpose. Route the analog inputs tracks (AINP, AINN) as a pair from the buffer to the converter using short, direct tracks and away from digital tracks.
  - A 1nF to 10nF capacitor should be used directly across the analog input pins, AINP and AINN. A low-k dielectric (such as COG or film type) should be used to maintain low THD. Capacitors from each analog input to ground can be used. They should be no larger than 1/10 the size of the difference capacitor (typically 100pF) to preserve the AC common-mode performance.
- 7. Component Placement: Place the power supply, analog input, and reference input bypass capacitors as close as possible to the device pins. This layout is particularly important for the small-value ceramic capacitors. Surface-mount components are recommended to avoid the higher inductance of leaded components.

Figure 26 to Figure 28 illustrate basic connections and interfaces that can be used with the ADS1174/78.

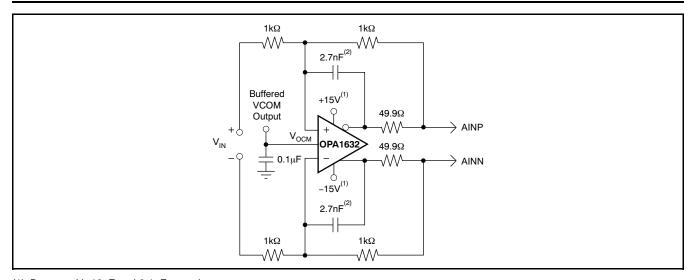




- (1) External Schottky clamp diodes or series resistors may be needed to prevent overvoltage on the inputs. See the Analog Inputs section.
- (2) Indicates ceramic capacitors.
- (3) Indicates COG ceramic capacitors.
- (4) For pin test mode, set to logic high.
- (5) The op amp and input RC components filter the REF1004 noise.
- (6) U1: SN74LVC1G04. U2: SN74LVC2G74. These components re-clock the ADS1174 data output to interface to the TMS320VC5509.

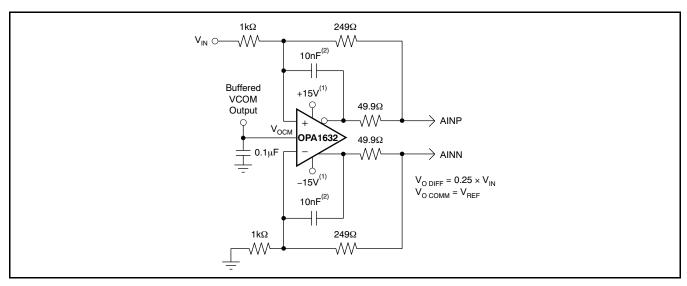
Figure 26. ADS1174 Basic Connection Circuit





- (1) Bypass with  $10\mu F$  and  $0.1\mu F$  capacitors.
- (2) 15nF for Low-Speed mode.

Figure 27. Basic Differential Input Signal Interface



- (1) Bypass with  $10\mu F$  and  $0.1\mu F$  capacitors.
- (2) 56nF for Low-Speed mode.

Figure 28. Basic Single-Ended Input Signal Interface



# POWERPAD THERMALLY-ENHANCED PACKAGING

The PowerPAD concept is implemented in standard epoxy resin package material. The integrated circuit is attached to the leadframe die pad using thermally conductive epoxy. The package is molded so that the leadframe die pad is exposed at a surface of the package. This exposure provides an extremely low thermal resistance to the path between the IC junction and the exterior case. The external surface of the leadframe die pad is located on the PCB side of the package, allowing the die pad to be attached to

the PCB using standard flow soldering techniques. This soldering allows efficient attachment to the PCB and permits the board structure to be used as a heat-sink for the package. Using a thermal pad identical in size to the die pad and vias connected to the PCB ground plane, the board designer can now implement power packaging without additional thermal hardware (for example, external heat sinks) or the need for specialized assembly instructions.

Figure 29 illustrates a cross-section view of a PowerPAD package.

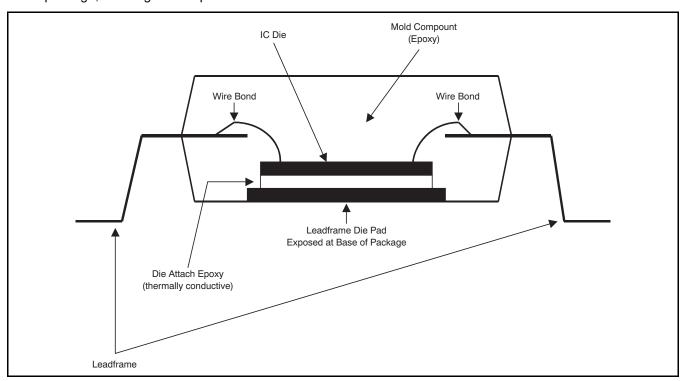


Figure 29. Cross-Section View of a PowerPAD Thermally-Enhanced Package



## PowerPAD PCB Layout Considerations for the ADS1174/78

Figure 30 shows the recommended layer structure for thermal management when using a PowerPad package on a 4-layer PCB design. Note that the thermal pad is placed on both the top and bottom sides of the board. The ground plane is used as the heat-sink, while the power plane is thermally isolated from the thermal vias.

Figure 31 shows the required thermal pad etch pattern for the 64-lead HTQFP package used for the ADS1174/78. Nine 13mil (0.33mm) thermal vias plated with one ounce of copper are placed within the thermal pad area for the purpose of connecting the pad to the ground plane layer. The ground plane is used as a heatsink in this application. It is very important that the thermal via diameter be no larger than 13mils in order to avoid solder wicking during the reflow process. Solder wicking results in thermal voids that reduce heat dissipation efficiency and hamper heat flow away from the IC die.

The via connections to the thermal pad and internal ground plane should be plated completely around the hole, as opposed to the typical web or spoke thermal relief connection. Plating entirely around the thermal via provides the most efficient thermal connection to the ground plane.

#### Additional PowerPAD Package Information

Texas Instruments publishes the PowerPAD Thermally-Enhanced Package Application Report (TI literature number SLMA002), available for download at www.ti.com, which provides a more detailed discussion of PowerPAD design and layout considerations. Before attempting a board layout with the ADS1174/78, it is recommended that the hardware engineer and/or layout designer be familiar with the information contained in this document.

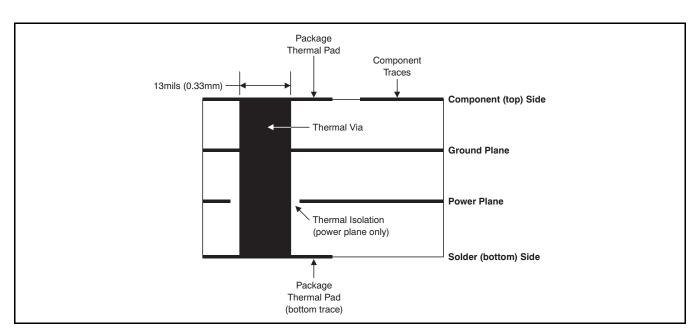


Figure 30. Recommended PCB Structure for a 4-Layer Board



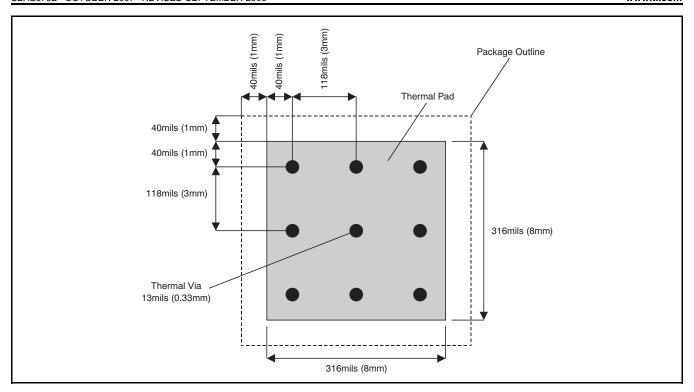


Figure 31. Thermal Pad Etch and Via Pattern for the 64-Lead HTQFP Package



#### www.ti.com

## **Revision History**

Cł	anges from Revision A (December 2007) to Revision B	Page
•	Corrected typo in the Absolute Maximum Ratings table	2
•	Corrected caption of Figure 21; FORMAT[2:0] = 000 or 001 (instead of 011 or 100)	21
•	Corrected caption of Figure 23; FORMAT[2:0] = 011 or 100 (instead of 000 or 001)	22
•	Revised the Power Supplies section	23
•	Changed Figure 26 illustrating Frame-Sync connection to the DSP	26



#### PACKAGE OPTION ADDENDUM

10-Dec-2020

#### **PACKAGING INFORMATION**

www.ti.com

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan	Lead finish/ Ball material	MSL Peak Temp	Op Temp (°C)	Device Marking (4/5)	Samples
ADS1174IPAPR	ACTIVE	HTQFP	PAP	64	1000	RoHS & Green	NIPDAU	Level-3-260C-168 HR	-40 to 85	ADS1174	Samples
ADS1174IPAPT	ACTIVE	HTQFP	PAP	64	250	RoHS & Green	NIPDAU	Level-3-260C-168 HR	-40 to 85	ADS1174	Samples
ADS1178IPAPR	ACTIVE	HTQFP	PAP	64	1000	RoHS & Green	NIPDAU	Level-3-260C-168 HR	-40 to 85	ADS1178	Samples
ADS1178IPAPT	ACTIVE	HTQFP	PAP	64	250	RoHS & Green	NIPDAU	Level-3-260C-168 HR	-40 to 85	ADS1178	Samples

(1) The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

(2) RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (CI) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

- (3) MSL, Peak Temp. The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.
- (4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.
- (5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.
- (6) Lead finish/Ball material Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

Important Information and Disclaimer: The information provided on this page represents TI's knowledge and belief as of the date that it is provided. TI bases its knowledge and belief on information provided by third parties, and makes no representation or warranty as to the accuracy of such information. Efforts are underway to better integrate information from third parties. TI has taken and



## **PACKAGE OPTION ADDENDUM**

10-Dec-2020

continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.

In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

## **PACKAGE MATERIALS INFORMATION**

www.ti.com 20-Oct-2021

### TAPE AND REEL INFORMATION





	Dimension designed to accommodate the component width
B0	Dimension designed to accommodate the component length
K0	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

#### QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



#### \*All dimensions are nominal

Device	Package Type	Package Drawing			Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
ADS1174IPAPT	HTQFP	PAP	64	250	180.0	24.4	13.0	13.0	1.5	16.0	24.0	Q2

www.ti.com 20-Oct-2021



#### \*All dimensions are nominal

	Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
I	ADS1174IPAPT	HTQFP	PAP	64	250	213.0	191.0	55.0

10 x 10, 0.5 mm pitch

QUAD FLATPACK

This image is a representation of the package family, actual package may vary. Refer to the product data sheet for package details.



## PAP (S-PQFP-G64)

## PowerPAD™ PLASTIC QUAD FLATPACK



NOTES:

- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion
- D. This package is designed to be soldered to a thermal pad on the board. Refer to Technical Brief, PowerPad Thermally Enhanced Package, Texas Instruments Literature No. SLMA002 for information regarding recommended board layout. This document is available at www.ti.com <a href="http://www.ti.com">http://www.ti.com</a>.
- E. Falls within JEDEC MS-026

PowerPAD is a trademark of Texas Instruments.

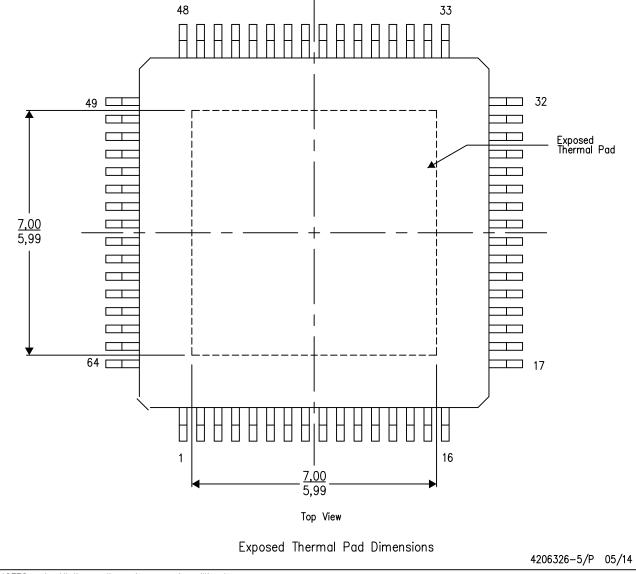


#### THERMAL INFORMATION

This PowerPAD package incorporates an exposed thermal pad that is designed to be attached to a printed circuit board (PCB). The thermal pad must be soldered directly to the PCB. After soldering, the PCB can be used as a heatsink. In addition, through the use of thermal vias, the thermal pad can be attached directly to the appropriate copper plane shown in the electrical schematic for the device, or alternatively, can be attached to a special heatsink structure designed into the PCB. This design optimizes the heat transfer from the integrated circuit (IC).

For additional information on the PowerPAD package and how to take advantage of its heat dissipating abilities, refer to Technical Brief, PowerPAD Thermally Enhanced Package, Texas Instruments Literature No. SLMA002 and Application Brief, PowerPAD Made Easy, Texas Instruments Literature No. SLMA004. Both documents are available at www.ti.com.

The exposed thermal pad dimensions for this package are shown in the following illustration.



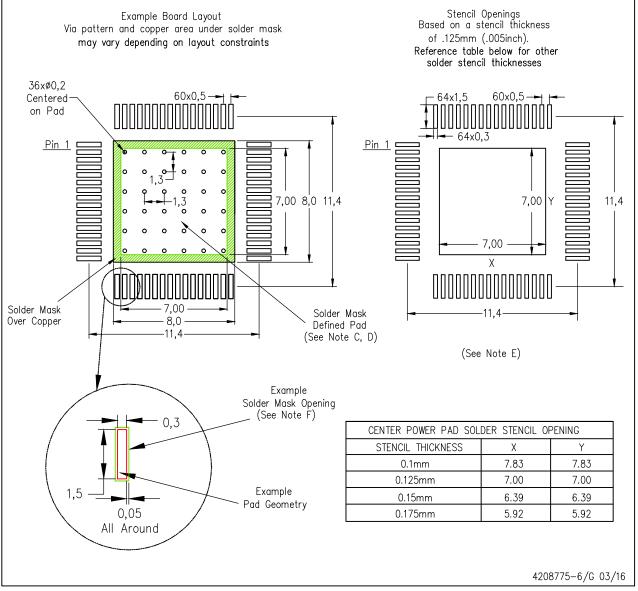
NOTES: A. All linear dimensions are in millimeters

PowerPAD is a trademark of Texas Instruments



## PAP (S-PQFP-G64)

## PowerPAD™ PLASTIC QUAD FLATPACK



NOTES:

- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.

- PowerPAD is a trademark of Texas Instruments
- C. Customers should place a note on the circuit board fabrication drawing not to alter the center solder mask defined pad.
- D. This package is designed to be soldered to a thermal pad on the board. Refer to Technical Brief, PowerPad Thermally Enhanced Package, Texas Instruments Literature No. SLMA002, SLMA004, and also the Product Data Sheets for specific thermal information, via requirements, and recommended board layout. These documents are available at www.ti.com <a href="http://www.ti.com">www.ti.com</a>. Publication IPC-7351 is recommended for alternate designs.
- E. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Example stencil design based on a 50% volumetric metal load solder paste. Refer to IPC-7525 for other stencil recommendations.
- F. Customers should contact their board fabrication site for solder mask tolerances between and around signal pads.



#### IMPORTANT NOTICE AND DISCLAIMER

TI PROVIDES TECHNICAL AND RELIABILITY DATA (INCLUDING DATA SHEETS), DESIGN RESOURCES (INCLUDING REFERENCE DESIGNS), APPLICATION OR OTHER DESIGN ADVICE, WEB TOOLS, SAFETY INFORMATION, AND OTHER RESOURCES "AS IS" AND WITH ALL FAULTS, AND DISCLAIMS ALL WARRANTIES, EXPRESS AND IMPLIED, INCLUDING WITHOUT LIMITATION ANY IMPLIED WARRANTIES OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE OR NON-INFRINGEMENT OF THIRD PARTY INTELLECTUAL PROPERTY RIGHTS.

These resources are intended for skilled developers designing with TI products. You are solely responsible for (1) selecting the appropriate TI products for your application, (2) designing, validating and testing your application, and (3) ensuring your application meets applicable standards, and any other safety, security, regulatory or other requirements.

These resources are subject to change without notice. TI grants you permission to use these resources only for development of an application that uses the TI products described in the resource. Other reproduction and display of these resources is prohibited. No license is granted to any other TI intellectual property right or to any third party intellectual property right. TI disclaims responsibility for, and you will fully indemnify TI and its representatives against, any claims, damages, costs, losses, and liabilities arising out of your use of these resources.

TI's products are provided subject to TI's Terms of Sale or other applicable terms available either on ti.com or provided in conjunction with such TI products. TI's provision of these resources does not expand or otherwise alter TI's applicable warranties or warranty disclaimers for TI products.

TI objects to and rejects any additional or different terms you may have proposed.

Mailing Address: Texas Instruments, Post Office Box 655303, Dallas, Texas 75265 Copyright © 2021, Texas Instruments Incorporated